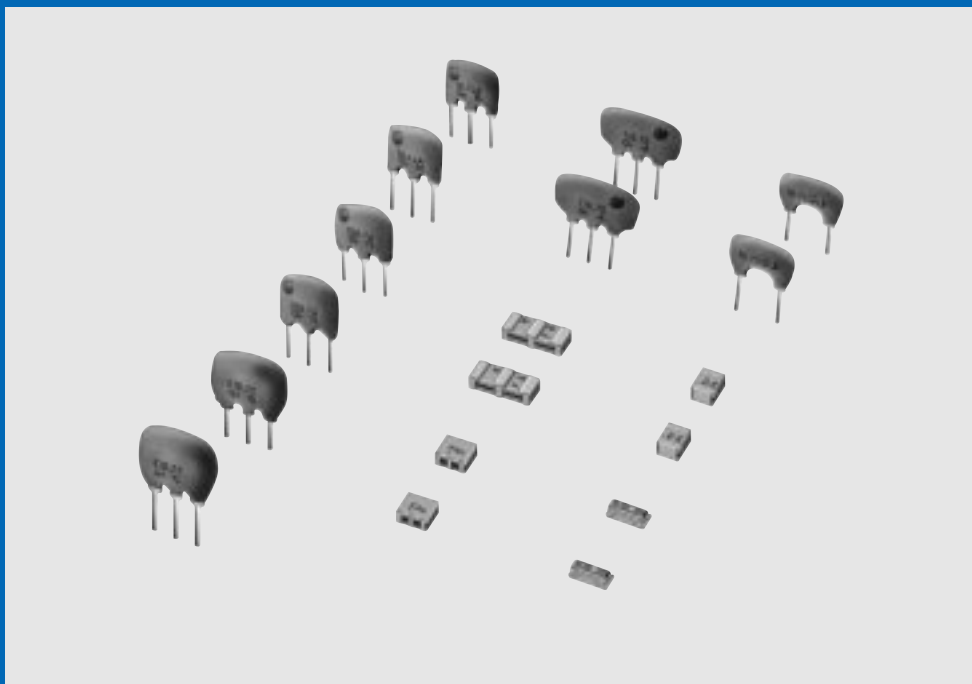


Ceramic Filters (CERAFIL[®]) for FM Receivers

CERAMIC FILTERS (CERAFIL[®])



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CERAFIL® and "CERAFIL" in this catalog are the trademarks of Murata Manufacturing Co., Ltd.

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● Part Numbering (The structure of the "Global Part Numbers" that have been adopted since June 2001 and the meaning of each code are described herein.) If you have any questions about details, inquire at your usual Murata sales office or distributor.

CERAFIL[®] for FM

(Global Part Number)

SF	E	LA	10M7	FAA0	-R0
----	---	----	------	------	-----

①②③④⑤⑥

① Product ID

Product ID	
SF	Ceramic Filters

② Oscillation/Numbers of Element

Code	Oscillation/Numbers of Element
E	2 Elements Thickness Expander mode
T	3 Elements Thickness Expander mode
K	2 Elements Thickness Expander mode (2nd Harmonic)
V	2 Elements Thickness Expander mode (3rd Over Tone)

③ Structure/Size

Code	Structure/Size
L□	Lead Type
C□	Chip Type

□ is expressed "A" or subsequent code, which indicates the size.

④ Nominal Center Frequency

Expressed by four-digit alphanumerics. The unit is in hertz (MHz).
Decimal point is expressed by capital letter "M".

Discriminators for FM

(Global Part Number)

CD	A	LA	10M7	GA	001	-R0
----	---	----	------	----	-----	-----

①②③④⑤⑥⑦

① Product ID

Product ID	
CD	Discriminators

② Oscillation

Code	Oscillation
A	Thickness Expander mode

③ Structure/Size

Code	Structure/Size
L□	Lead Type
C□	Chip Type

□ is expressed "A" or subsequent code, which indicates the size.

④ Nominal Center Frequency

Expressed by four-digit alphanumerics. The unit is in hertz (MHz).
Decimal point is expressed by capital letter "M".

⑤ Product Specification

Code	Product Specification
FAA0	Four-digit alphanumerics express pass-bandwidth, center frequency tolerance, rank, series, others.

⑥ Packaging

Code	Packaging
-B0	Bulk
-R0	Plastic Taping ø180mm
-R1	Plastic Taping ø330mm
-A0	1500pcs. /Radial Taping H ₀ =18mm
-A1	1000pcs. /Radial Taping H ₀ =18mm

Radial taping is applied to lead type and plastic taping to chip type.
With non-standard products, two-digit alphanumerics indicating "Individual Specification" is added between "⑤ Product Specification" and "⑥ Packaging".

⑤ Product Specification

Code	Product Specification
GA	Two-digit alphanumerics express type, center frequency, rank, others

⑥ IC

Code	IC
001	Applicable IC Control Code

⑦ Packaging

Code	Packaging
-B0	Bulk
-A0	Radial Taping H ₀ =18mm
-R0	Plastic Taping (ø180mm)
-R1	Plastic Taping (ø330mm)

Radial taping is applied to lead type and plastic taping to chip type.
With non-standard products, an alphanumerics indicating "Individual Specification" is added between "⑥ IC" and "⑦ Packaging".

Ceramic Filters (CERAFIL®) for FM Receivers



1

CERAFIL® Chip Type SFECV Series

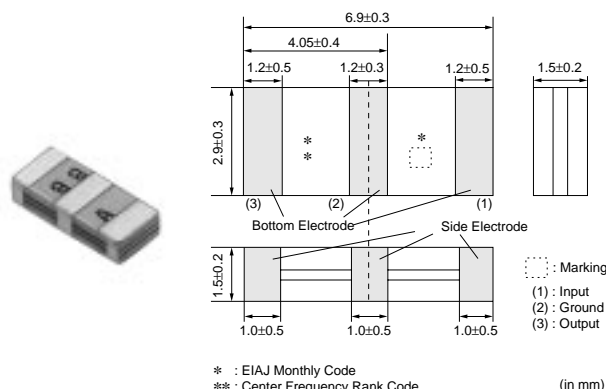
SFECV10M7 series for FM-receivers are monolithic type ceramic filters which utilize the energy trapped thickness vibration-mode of the piezoelectric ceramic. By taking advantage of the very low profile, new SFECV series and PFWCC(kHz filter for AM receiver) enable costumers to make AM/FM set so thin, and it can be of help to the total chip circuit.

■ Features

1. Super-thin. Only 1.5mm. The most suitable ceramic filter available for thinning substrates.
2. Heat resistant. Reflow soldering can be performed because of its excellent heat resistance.
3. Piezoelectric element is connected in the sandwich shape by heat resistant substrate, thus it has excellent mechanical strength, and it is suitable for automatic mounting.
4. Various bandwidths are available. Select a suitable type in accordance with the desired selectivity.
5. Electrical characteristics are the same as conventional "CERAFIL".

■ Applications

1. Small, thin radios
2. Automotive radios
3. Headphone stereos



Part Number	Center Frequency (fo) (MHz)	3dB Bandwidth (kHz)	Attenuation (kHz)	Insertion Loss (dB)	Spurious Attenuation (dB)
SFECV10M7KA00-R0	10.700 ±30kHz	within110 ±30kHz	320 max.	within6.0 ±2.0dB	35 min.
SFECV10M7JA00-R0	10.700 ±30kHz	within150 ±40kHz	380 max.	10.0 max.	30 min.
SFECV10M7HA00-R0	10.700 ±30kHz	within180 ±40kHz	470 max.	within4.0 ±2.0 dB	35 min.
SFECV10M7GA00-R0	10.700 ±30kHz	within230 ±50kHz	510 max.	within3.5 ±2.0 dB	35 min.
SFECV10M7FA00-R0	10.700 ±30kHz	within280 ±50kHz	590 max.	within3.0 ±2.0 dB	35 min.

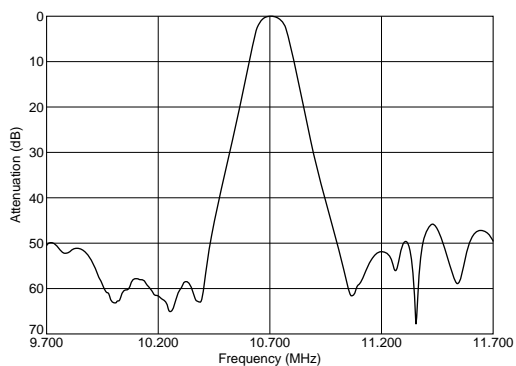
Area of Attenuation : [within 20dB] Area of Spurious Attenuation : [within 9MHz to 12MHz]
Center frequency(fo) defined by the center of 3dB bandwidth.

■ Center Frequency Rank Code

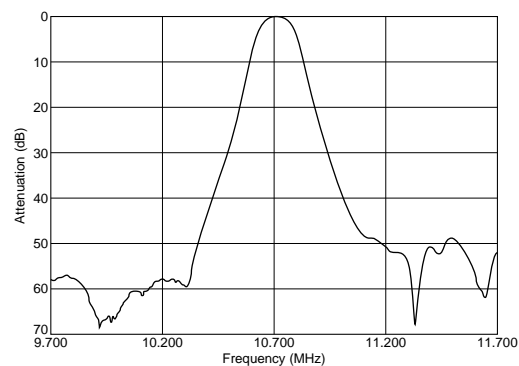
CODE	30kHz Step	25kHz Step
D	10.64MHz±30kHz	10.650MHz±25kHz
B	10.67MHz±30kHz	10.675MHz±25kHz
A	10.70MHz±30kHz	10.700MHz±25kHz
C	10.73MHz±30kHz	10.725MHz±25kHz
E	10.76MHz±30kHz	10.750MHz±25kHz
Z	Combination A,B,C,D,E	
M	Combination A,B,C	

Frequency Characteristics

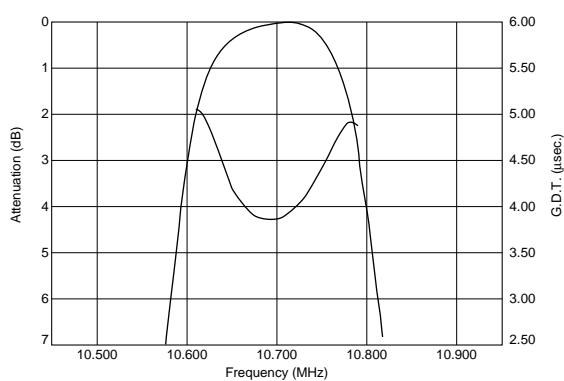
SFECV10M7KA00-R0



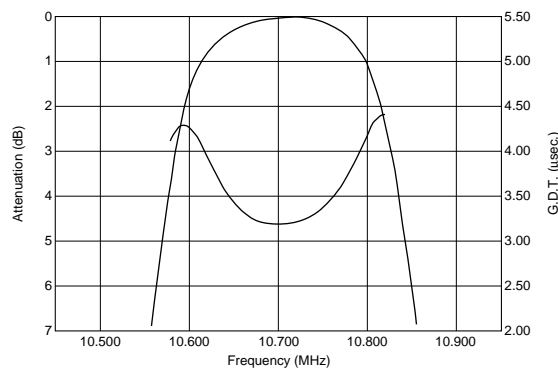
SFECV10M7JA00-R0



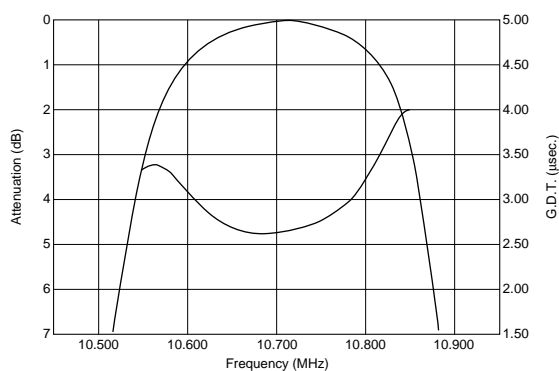
SFECV10M7HA00-R0



SFECV10M7GA00-R0

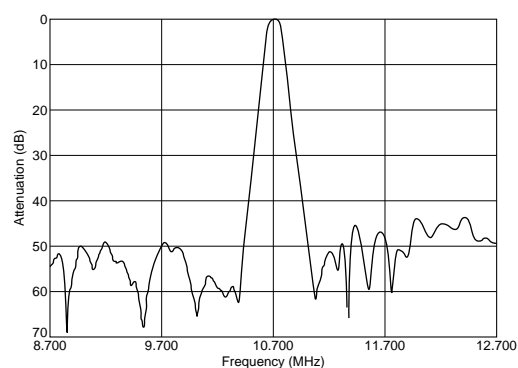


SFECV10M7FA00-R0

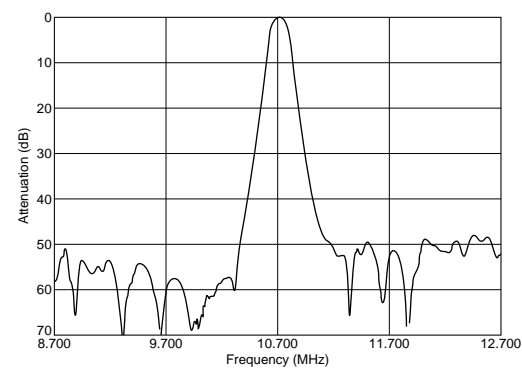


Frequency Characteristics (Spurious)

SFECV10M7KA00-R0

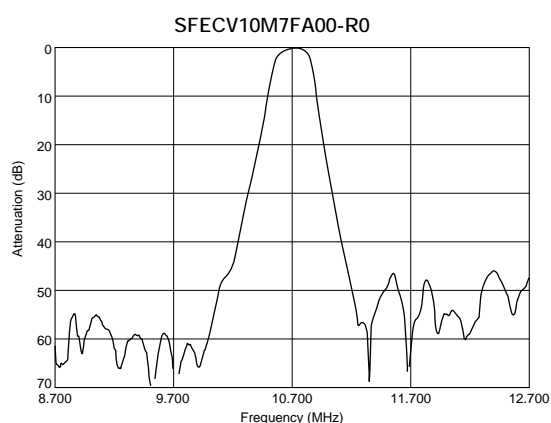
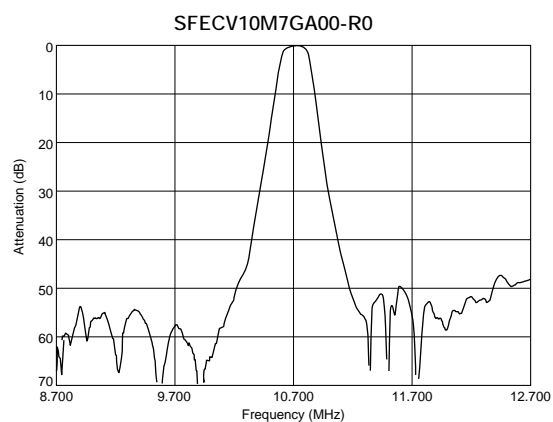
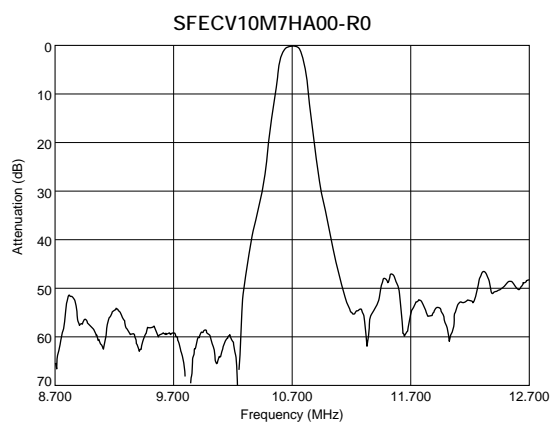


SFECV10M7JA00-R0

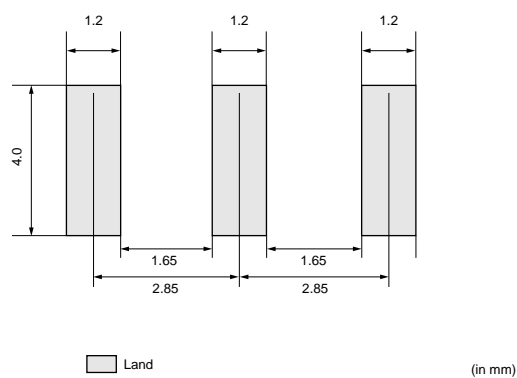


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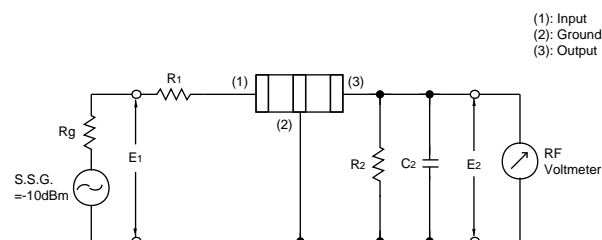
Frequency Characteristics (Spurious)



Standard Land Pattern Dimensions



Test Circuit



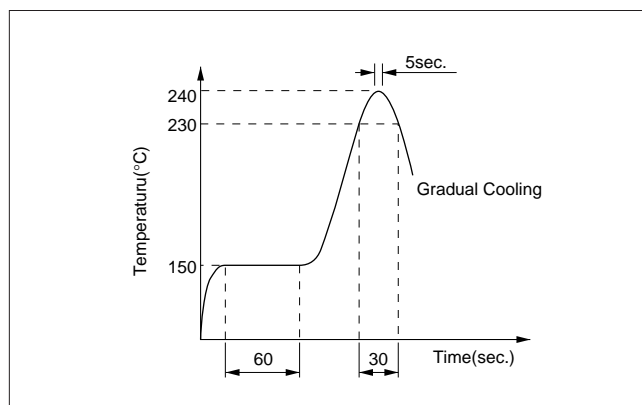
$R_g = 50\Omega$ $R_1 = 280\Omega \pm 5\%$ $R_2 = 330\Omega \pm 5\%$
 $C_2 = 10 \pm 2 \text{ pF}$ (Including stray capacitance and Input capacitance of RF Volt Meter)
 E_1 : S.S.G. S.S.G. Output Voltage

Chip CERAFIL® SFECV Series Notice

■ Notice (Soldering and Mounting)

1. Standard Reflow Soldering Condition

(1) Reflow



(2) Soldering Iron

Lead terminal is directly contacted with the tip of soldering iron of $280 \pm 5^\circ\text{C}$ for 3.0 ± 0.5 seconds.

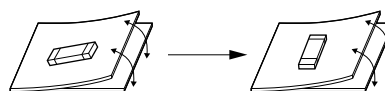
2. Wash

The component cannot be withstand washing.

■ Notice (Handling)

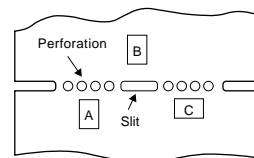
1. The component will be damaged when an excessive stress is applied.
2. The component may be damaged if excess mechanical stress is applied to it mounted on the printed circuit board.
3. Design layout of components on the PC board to minimize the stress imposed on the warp or flexure of the board.
4. After installing chips, if solder is excessively applied to the circuit board, mechanical stress will cause destruction resistance characteristics to lower. To prevent this, be extremely careful in determining shape and dimension before designing the circuit board diagram.
5. When the positioning claws and pick up nozzle are worn, the load is applied to the chip while positioning is concentrated to one positioning accuracy, etc. Careful checking and maintenance are necessary to prevent unexpected trouble.
6. When correcting chips with a soldering iron, the tip of the soldering iron should not directly touch the chip component. Depending on the soldering conditions, the effective area of terminations may be reduced. the use of solder containing Ag should be done to prevent the electrode erosion.
7. Do not clean or wash the component as it is not hermetically sealed.
8. In case of covering filter with over coat, conditions such as material of resin, cure temperature, and so on should be evaluated well.
9. Do not use strong acidity flux, more than 0.2wt% chlorine content, in re-flow soldering.
10. Accurate test circuit values are required to measure electrical characteristics. It may be a cause of mis-correlation if there is any deviation, especially stray capacitance, from the test circuit in the specification.

[Component direction]



Put the component lateral to the direction in which stress acts.


[Component layout close to board]



Susceptibility to stress is in the order of : A>C>B

myRata

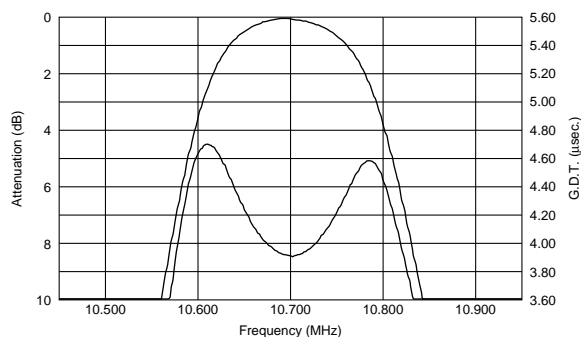
2



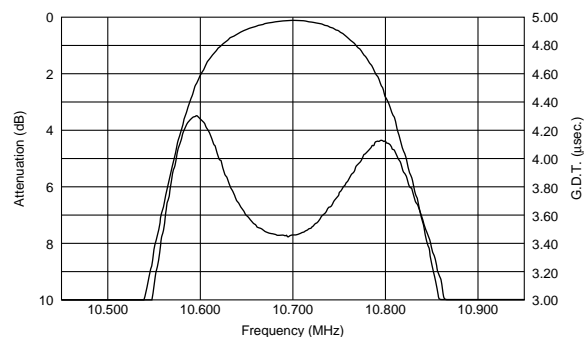
CODE	30kHz Step	25kHz Step
D	10.64MHz±30kHz	10.650MHz±25kHz
B	10.67MHz±30kHz	10.675MHz±25kHz
A	10.70MHz±30kHz	10.700MHz±25kHz
C	10.73MHz±30kHz	10.725MHz±25kHz
E	10.76MHz±30kHz	10.750MHz±25kHz
Z	Combination A,B,C,D,E	
M	Combination A,B,C	

Frequency Characteristics

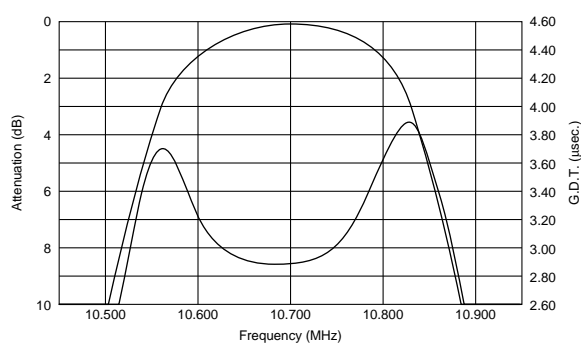
SFECS10M7HA00-R0



SFECS10M7GA00-R0

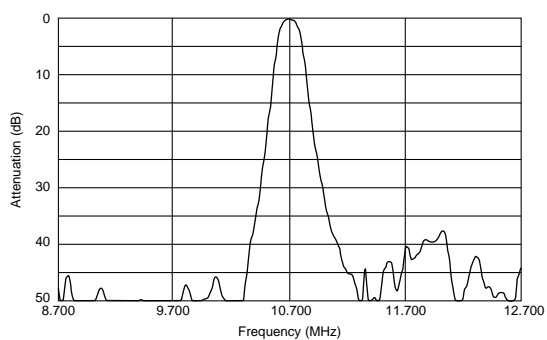


SFECS10M7FA00-R0

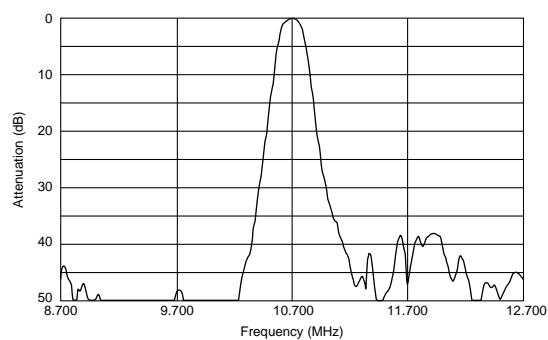


Frequency Characteristics (Spurious)

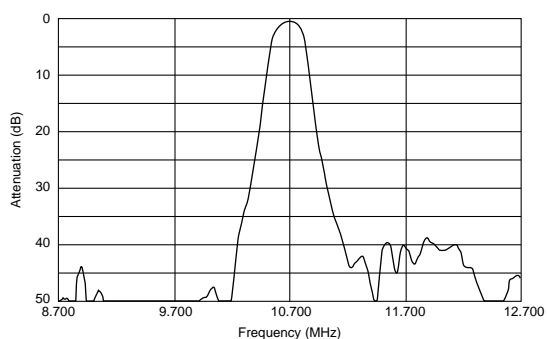
SFECS10M7HA00-R0



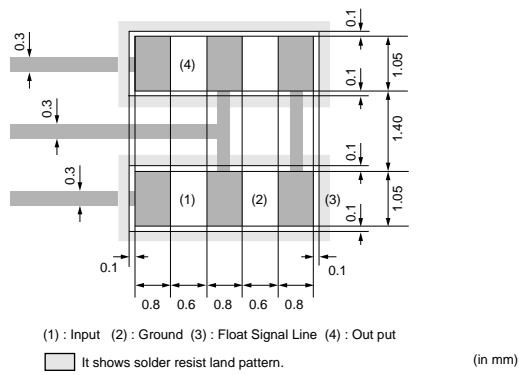
SFECS10M7GA00-R0



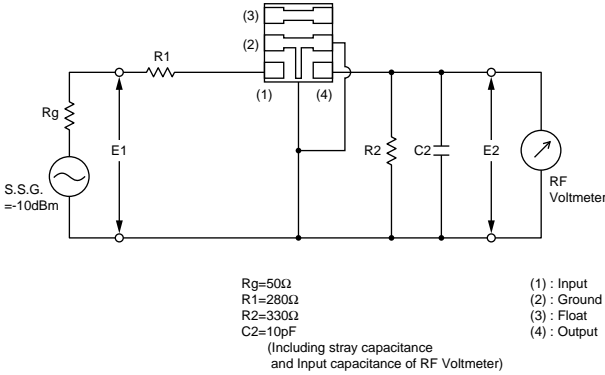
SFECS10M7FA00-R0



■ Standard Land Pattern Dimensions



■ Test Circuit



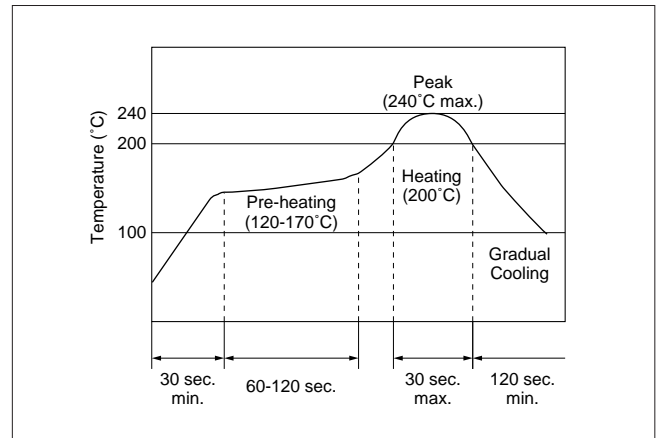
Chip CERAFIL® SFECS Series Notice

2

■ Notice (Soldering and Mounting)

1. Standard Reflow Soldering Condition

(1) Reflow



(2) Soldering Iron

Filter shall be soldered at $280 \pm 5^\circ\text{C}$ for 3.0 ± 0.5 seconds.

The soldering iron shall not touch the filter white soldering.

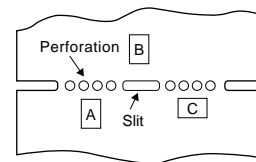
2. Wash

The component cannot be withstand washing.

■ Notice (Handling)

1. The component will be damaged when an excessive stress is applied.
2. The component may be damaged if excess mechanical stress is applied to it mounted on the printed circuit board.
3. Design layout of components on the PC board to minimize the stress imposed on the warp or flexure of the board.
4. After installing chips, if solder is excessively applied to the circuit board, mechanical stress will cause destruction resistance characteristics to lower. To prevent this, be extremely careful in determining shape and dimension before designing the circuit board diagram.
5. When the positioning claws and pick up nozzle are worn, the load is applied to the chip while positioning is concentrated to one positioning accuracy, etc. Careful checking and maintenance are necessary to prevent unexpected trouble.
6. When correcting chips with a soldering iron, the tip of the soldering iron should not directly touch the chip component. Depending on the soldering conditions, the effective area of terminations may be reduced. The use of solder containing Ag should be done to prevent the electrode erosion.
7. Do not clean or wash the component as it is not hermetically sealed.
8. In case of covering filter with over coat, conditions such as material of resin, cure temperature, and so on should be evaluated well.
9. Do not use strong acidity flux, more than 0.2wt% chlorine content, in re-flow soldering.
10. Accurate test circuit values are required to measure electrical characteristics.
It may be a cause of mis-correlation if there is any deviation, especially stray capacitance, from the test circuit in the specification.

[Component layout close to board]



Susceptibility to stress is in the order of : $A > C > B$

Ceramic Filters (CERAFIL[®]) for FM Receivers



CERAFIL[®] Standard Lead Type

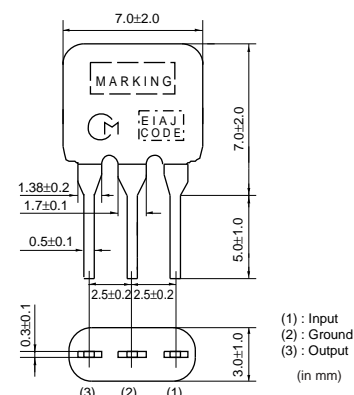
SFELA10M7 series for FM-receivers are monolithic type ceramic filters which use the energy trapped thickness vibration-mode of the piezoelectric ceramic.

■ Features

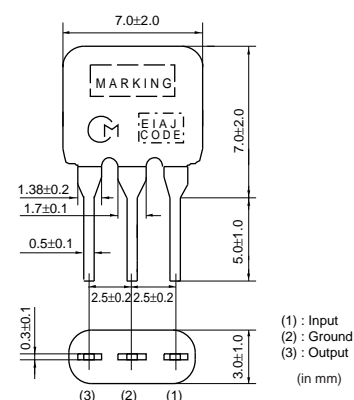
1. These miniature filters have high mechanical strength.
2. Low loss, favorable waveform symmetry, and high selectivity.
3. Various band widths are available for applications in wide to narrow bands.
4. Small dispersion and stable characteristics.
5. Change in center frequency is typically within $\pm 30\text{ppm}/(\text{degree C})$ at -20 to $+80$ (degree C).
6. High reliability.



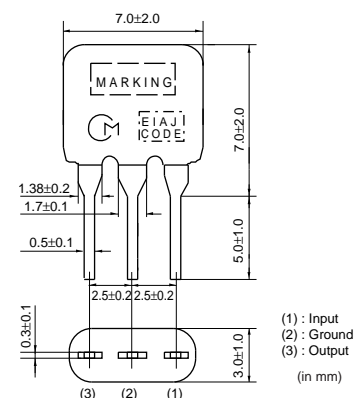
SFELA10M7HA00-B0



SFELA10M7GA00-B0



SFELA10M7FA00-B0



Part Number	Center Frequency (fo) (MHz)	3dB Bandwidth (kHz)	Attenuation (kHz)	Insertion Loss (dB)	Spurious Attenuation (dB)
SFELA10M7HA00-B0	10.700 ±30kHz	within 180 ±40kHz	520 max.	7.0 max.	40 min.
SFELA10M7GA00-B0	10.700 ±30kHz	within 230 ±50kHz	570 max.	within 4.0 ±2.0dB	40 min.
SFELA10M7FA00-B0	10.700 ±30kHz	within 280 ±50kHz	650 max.	within 4.0 ±2.0dB	30 min.

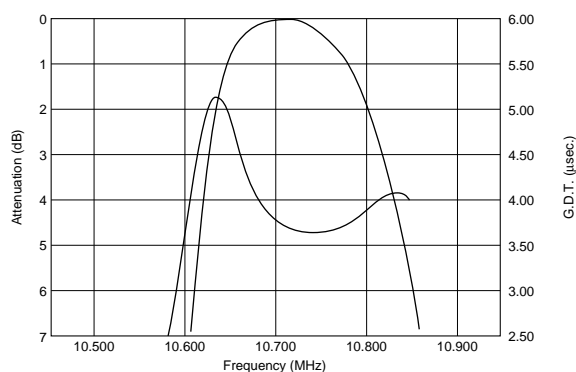
Area of Attenuation : [within 20dB] Area of Spurious Attenuation : [within 9MHz to 12MHz]
Center frequency(fo) defined by the center of 3dB bandwidth.

Center Frequency Rank Code

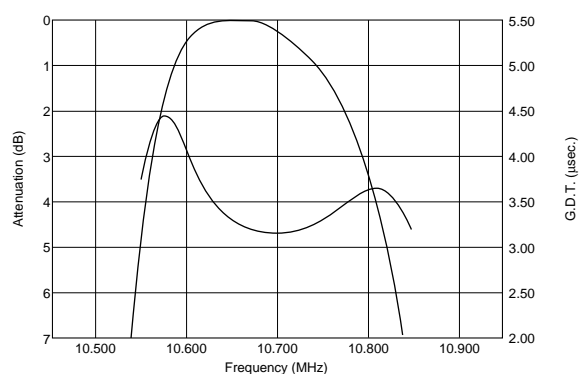
CODE	30kHz Step	25kHz Step
D	10.64MHz±30kHz	10.650MHz±25kHz
B	10.67MHz±30kHz	10.675MHz±25kHz
A	10.70MHz±30kHz	10.700MHz±25kHz
C	10.73MHz±30kHz	10.725MHz±25kHz
E	10.76MHz±30kHz	10.750MHz±25kHz
Z	Combination A,B,C,D,E	
M	Combination A,B,C	

Frequency Characteristics

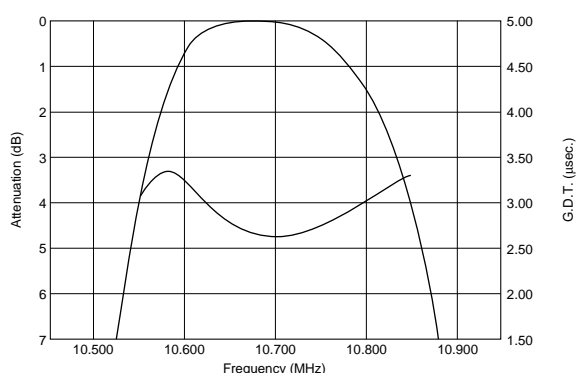
SFELA10M7HA00-B0



SFELA10M7GA00-B0

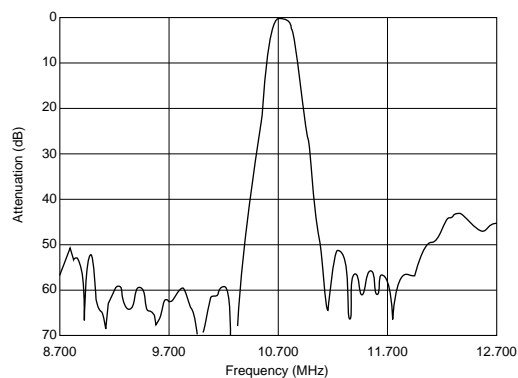


SFELA10M7FA00-B0

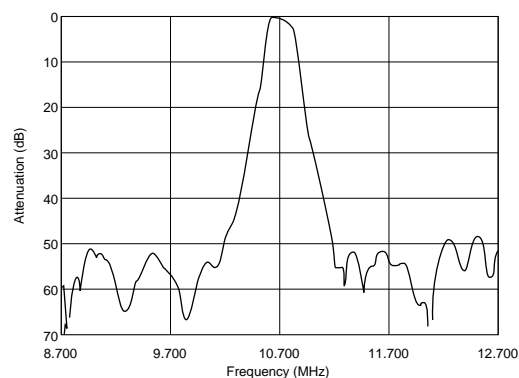


Frequency Characteristics (Spurious)


SFELA10M7HA00-B0



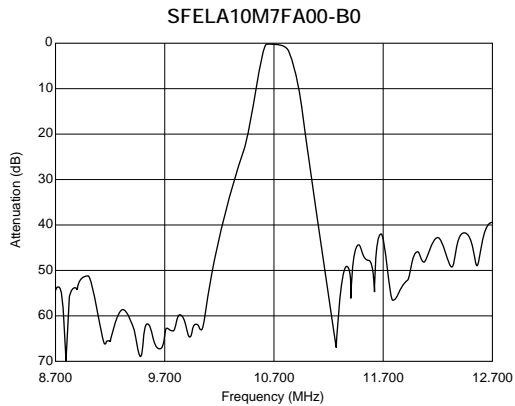
SFELA10M7GA00-B0



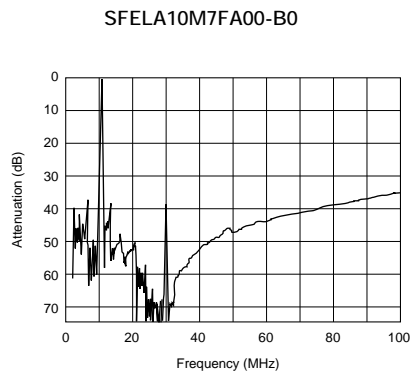
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Frequency Characteristics (Spurious)



Spurious Response



Ceramic Filters (CERAFIL[®]) for FM Receivers



CERAFIL[®] Low-loss Type

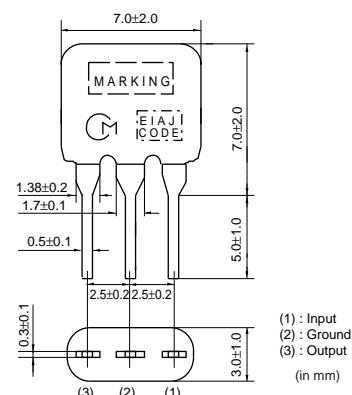
SFELA10M7 series for FM-receivers are monolithic type ceramic filters which use the energy trapped thickness vibration-mode of the piezoelectric ceramic.

■ Features

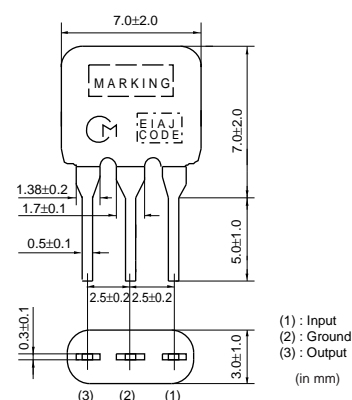
1. Insertion loss is 1 to 1.5dB lower than conventional products. This types are useful for elevating the sensitivity of sets.
2. Small dispersion and stable characteristics.
3. Excellent shape factor of frequency response.
4. Good waveform symmetry.



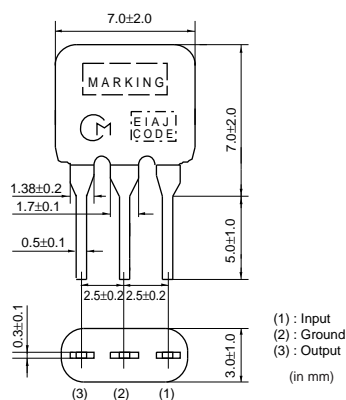
SFELA_JAA0-B0



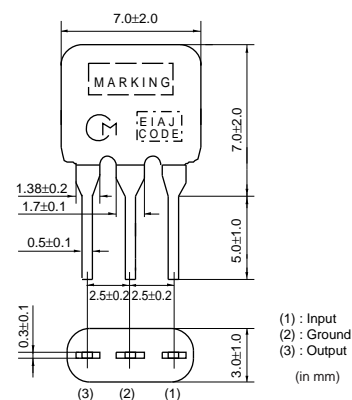
SFELA_HAA0-B0



SFELA_GAA0-B0



SFELA_FAA0-B0



Part Number	Center Frequency (fo) (MHz)	3dB Bandwidth (kHz)	Attenuation (kHz)	Insertion Loss (dB)	Spurious Attenuation (dB)
SFELA10M7JAA0-B0	10.700 ±30kHz	within150 ±40kHz	360 max.	within4.5 ±2.0dB	35 min.
SFELA10M7HAA0-B0	10.700 ±30kHz	within180 ±40kHz	470 max.	within3.5 ±1.5dB	35 min.
SFELA10M7GAA0-B0	10.700 ±30kHz	within230 ±50kHz	520 max.	within3.0 ±2.0dB	35 min.
SFELA10M7FAA0-B0	10.700 ±30kHz	within280 ±50kHz	590 max.	within2.5 ±2.0dB	30 min.

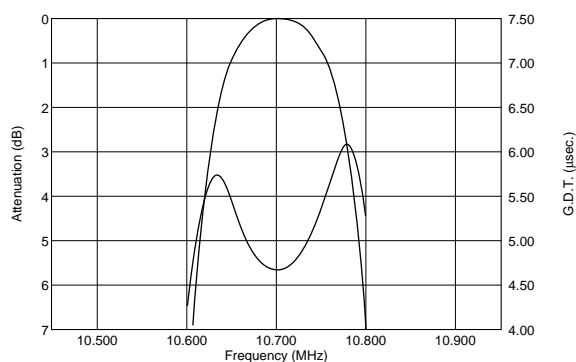
Area of Attenuation : [within 20dB] Area of Spurious Attenuation : [within 9MHz to 12MHz]
Center frequency(fo) defined by the center of 3dB bandwidth.

Center Frequency Rank Code

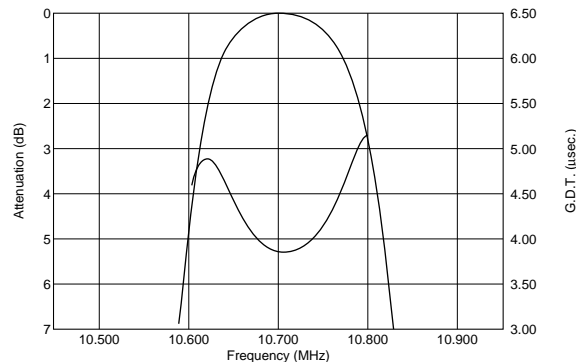
CODE	30kHz Step	25kHz Step
D	10.64MHz±30kHz	10.650MHz±25kHz
B	10.67MHz±30kHz	10.675MHz±25kHz
A	10.70MHz±30kHz	10.700MHz±25kHz
C	10.73MHz±30kHz	10.725MHz±25kHz
E	10.76MHz±30kHz	10.750MHz±25kHz
Z	Combination A,B,C,D,E	
M	Combination A,B,C	

Frequency Characteristics

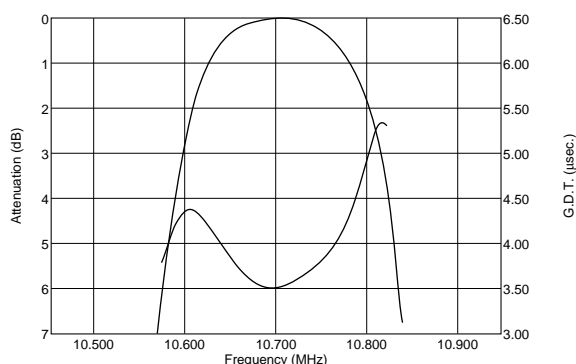
SFELA10M7JAA0-B0



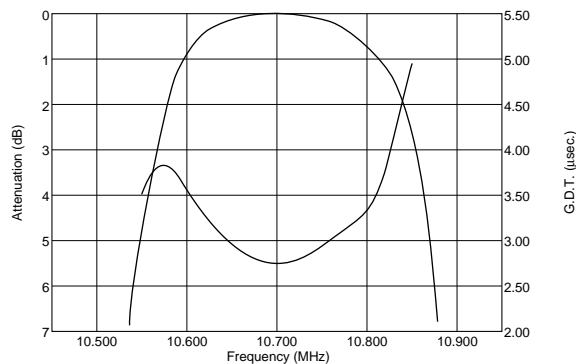
SFELA10M7HAA0-B0



SFELA10M7GAA0-B0

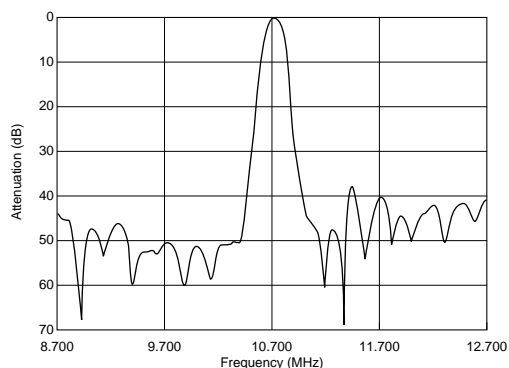


SFELA10M7FAA0-B0

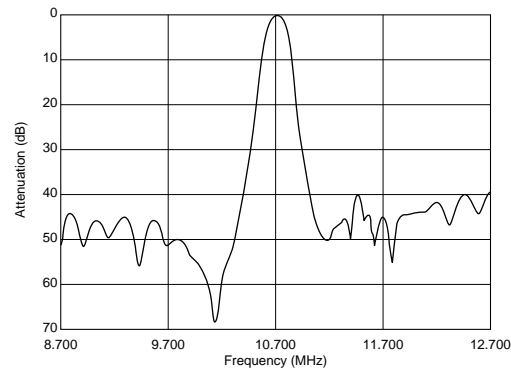


Frequency Characteristics (Spurious)

SFELA10M7JAA0-B0



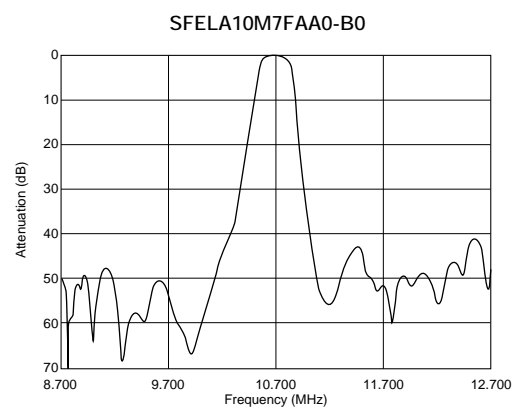
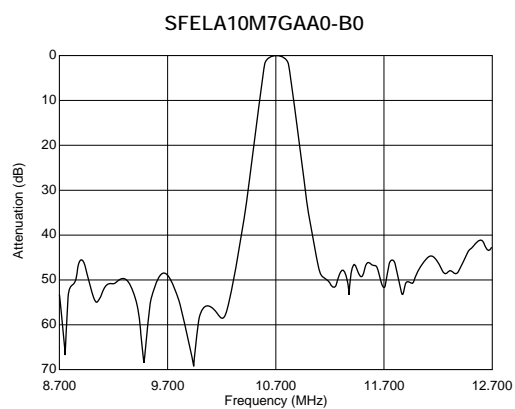
SFELA10M7HAA0-B0



Continued on the following page.

Continued from the preceding page.

Frequency Characteristics (Spurious)



Ceramic Filters (CERAFIL[®]) for FM Receivers



CERAFIL[®] Low-profile Type

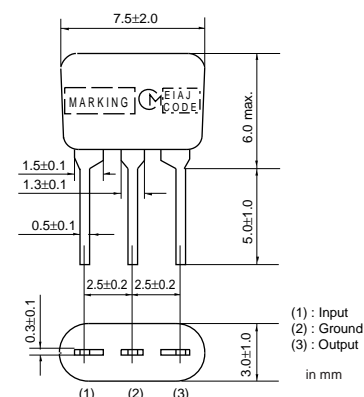
SFELB10M7 series for FM-receivers are monolithic type ceramic filters which use the energy trapped thickness vibration-mode of the piezoelectric ceramic.

■ Features

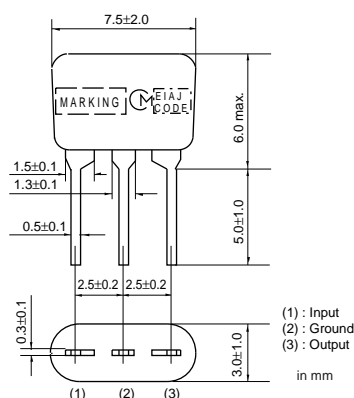
1. Installed height is 5 mm, making it well suited for compact, thin sets.
2. Environmental reliability is the same as those of the ceramic filter SFELA10M7 series.



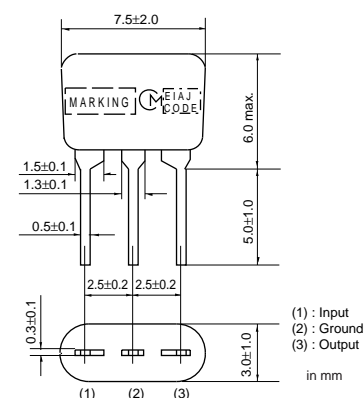
SFELB10M7KA00-B0



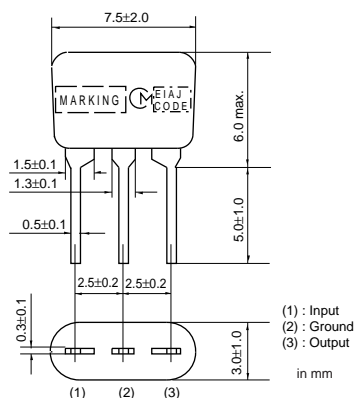
SFELB10M7JA00-B0



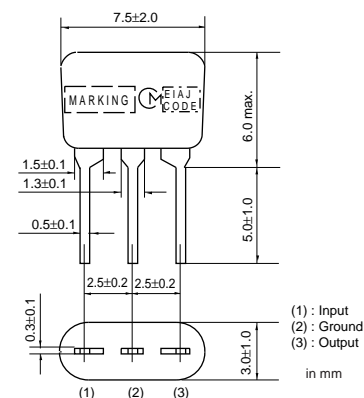
SFELB10M7HA00-B0



SFELB10M7GA00-B0



SFELB10M7FA00-B0



Part Number	Center Frequency (fo) (MHz)	3dB Bandwidth (kHz)	Attenuation (kHz)	Insertion Loss (dB)	Spurious Attenuation (dB)
SFELB10M7KA00-B0	10.700 ±30kHz	within 110 ±30kHz	350 max.	within 7.0 ±2.0dB	30 min.
SFELB10M7JA00-B0	10.700 ±30kHz	within 150 ±40kHz	360 max.	within 4.5 ±2.0dB	35 min.
SFELB10M7HA00-B0	10.700 ±30kHz	within 180 ±40kHz	470 max.	within 3.5 ±2.0dB	35 min.
SFELB10M7GA00-B0	10.700 ±30kHz	within 230 ±50kHz	570 max.	within 3.0 ±2.0dB	40 min.
SFELB10M7FA00-B0	10.700 ±30kHz	within 280 ±50kHz	650 max.	within 3.0 ±2.0dB	30 min.

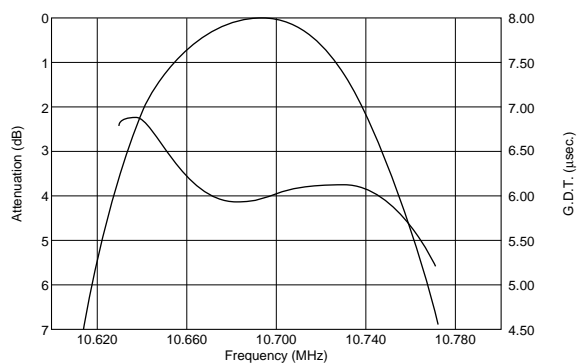
Area of Attenuation : [within 20dB] Area of Spurious Attenuation : [within 9MHz to 12MHz]
Center frequency(fo) defined by the center of 3dB bandwidth.

Center Frequency Rank Code

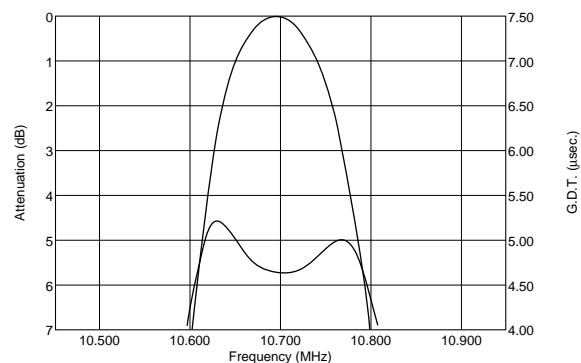
CODE	30kHz Step	25kHz Step
D	10.64MHz±30kHz	10.650MHz±25kHz
B	10.67MHz±30kHz	10.675MHz±25kHz
A	10.70MHz±30kHz	10.700MHz±25kHz
C	10.73MHz±30kHz	10.725MHz±25kHz
E	10.76MHz±30kHz	10.750MHz±25kHz
Z	Combination A,B,C,D,E	
M	Combination A,B,C	

Frequency Characteristics

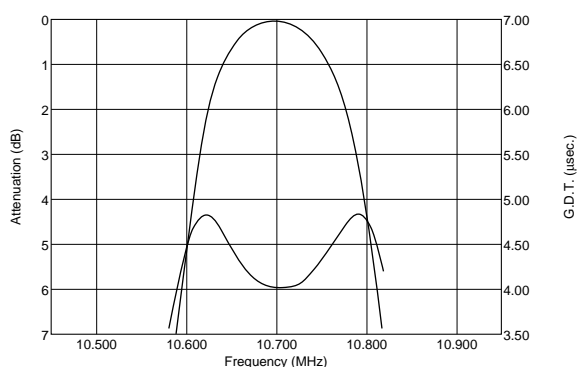
SFELB10M7KA00-B0



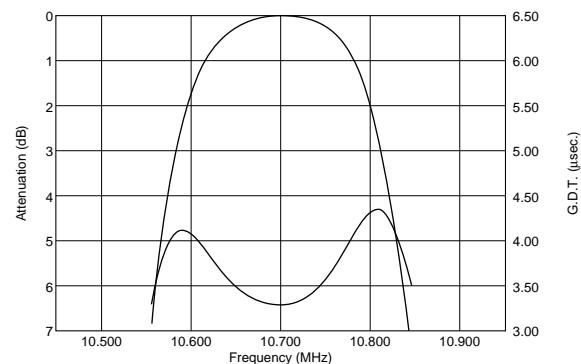
SFELB10M7JA00-B0



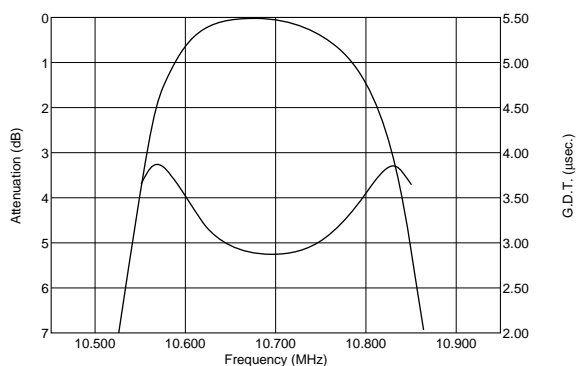
SFELB10M7HA00-B0



SFELB10M7GA00-B0

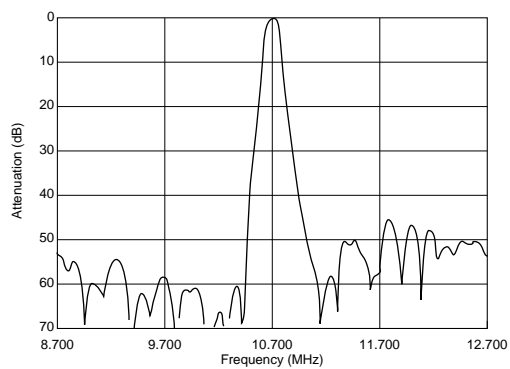


SFELB10M7FA00-B0

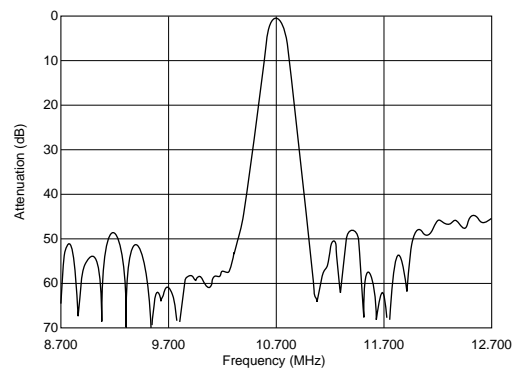


■ Frequency Characteristics (Spurious)

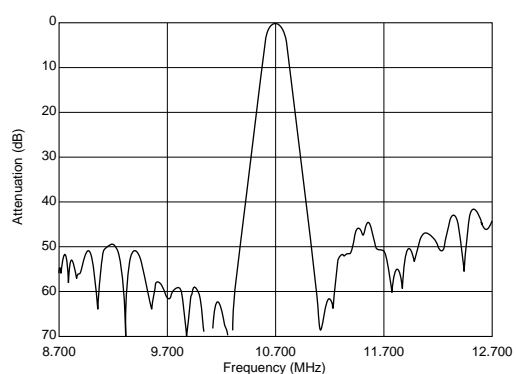
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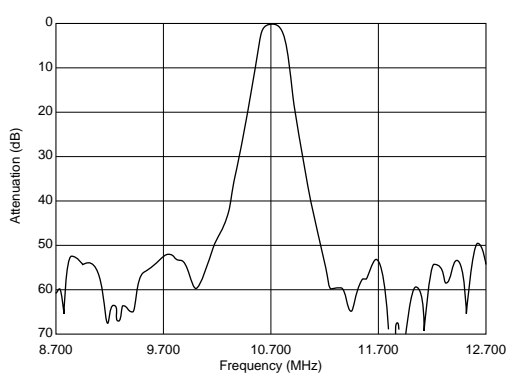
SFELB10M7JA00-B0



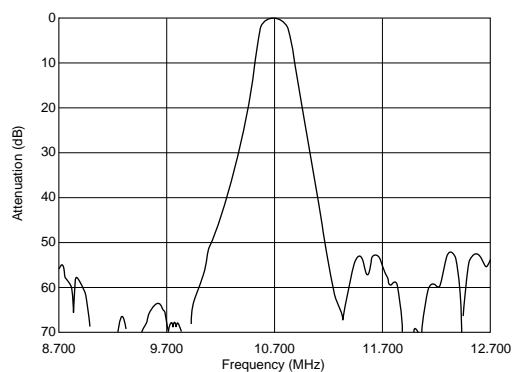
SFELB10M7HA00-B0



SFELB10M7GA00-B0



SFELB10M7FA00-B0



Ceramic Filters (CERAFIL®) for FM Receivers



CERAFIL® Lower Spurious Response Type

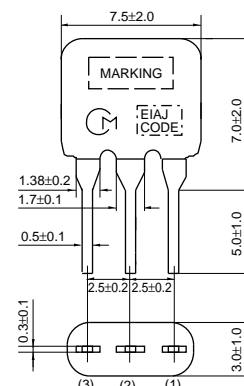
SFELA10M7 series for FM-receivers are monolithic type ceramic filters which use the energy trapped thickness vibration-mode of the piezoelectric ceramic.

■ Features

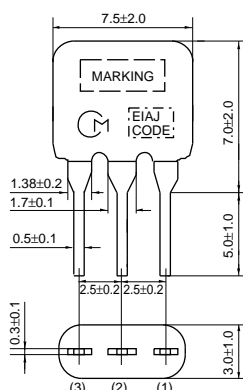
1. This type has lower spurious response compared to the standard filters.
2. This types are suitable for higher spurious suppression ratio.



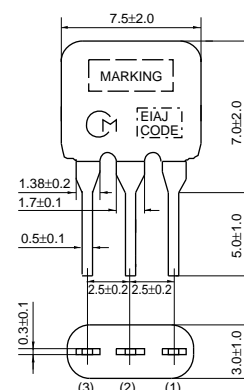
SFELA10M7KAB0-B0



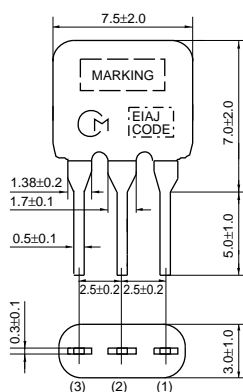
SFELA10M7JAB0-B0



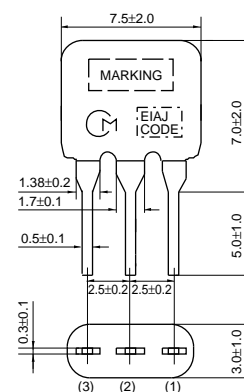
SFELA10M7HAB0-B0



SFELA10M7GAB0-B0



SFELA10M7FAB0-B0



Part Number	Center Frequency (fo) (MHz)	3dB Bandwidth (kHz)	Attenuation (kHz)	Insertion Loss (dB)	Spurious Attenuation (dB)
SFELA10M7KAB0-B0	10.700 ±30kHz	within110 ±30kHz	350 max.	7.0 ±2.0dB	45 min.
SFELA10M7JAB0-B0	10.700 ±30kHz	within150 ±40kHz	380 max.	5.5 ±2.0dB	45 min.
SFELA10M7HAB0-B0	10.700 ±30kHz	within180 ±40kHz	520 max.	5.0 ±2.0dB	45 min.
SFELA10M7GAB0-B0	10.700 ±30kHz	within230 ±50kHz	570 max.	3.0 ±2.0dB	45 min.
SFELA10M7FAB0-B0	10.700 ±30kHz	within280 ±50kHz	650 max.	3.0 ±2.0dB	45 min.

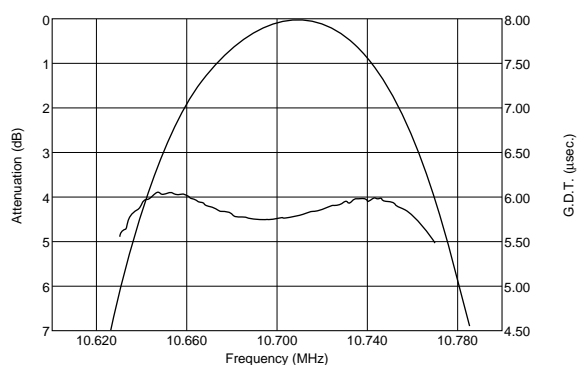
Area of Attenuation : [within 20dB] Area of Spurious Attenuation : [within 9MHz to 12MHz]
Center frequency(fo) defined by the center of 3dB bandwidth.

Center Frequency Rank Code

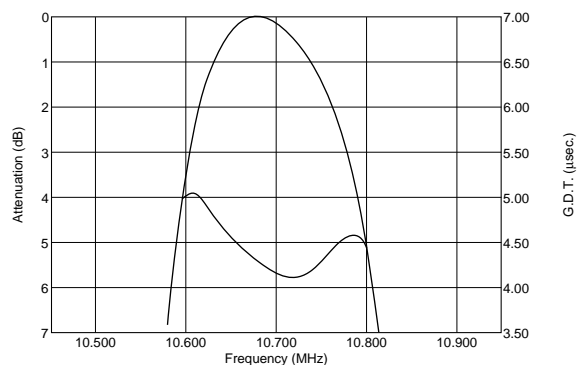
CODE	30kHz Step	25kHz Step
D	10.64MHz±30kHz	10.650MHz±25kHz
B	10.67MHz±30kHz	10.675MHz±25kHz
A	10.70MHz±30kHz	10.700MHz±25kHz
C	10.73MHz±30kHz	10.725MHz±25kHz
E	10.76MHz±30kHz	10.750MHz±25kHz
Z	Combination A,B,C,D,E	
M	Combination A,B,C	

Frequency Characteristics

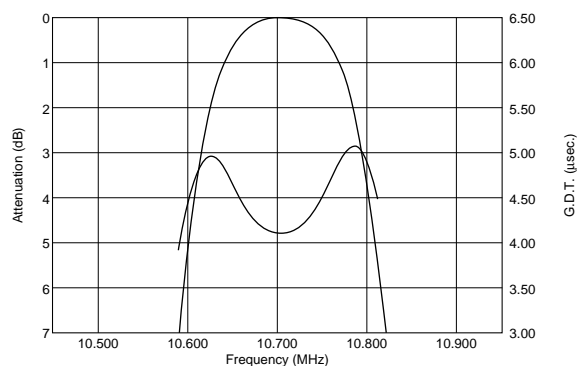
SFELA10M7KAB0-B0



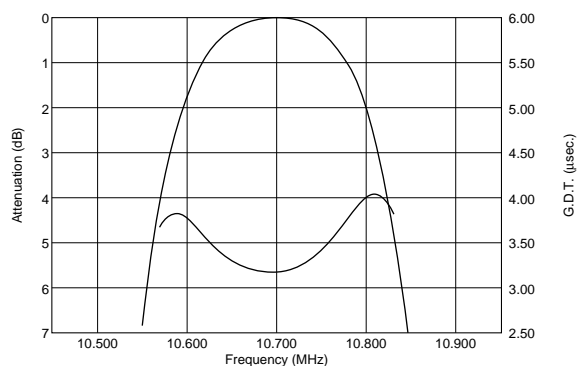
SFELA10M7JAB0-B0



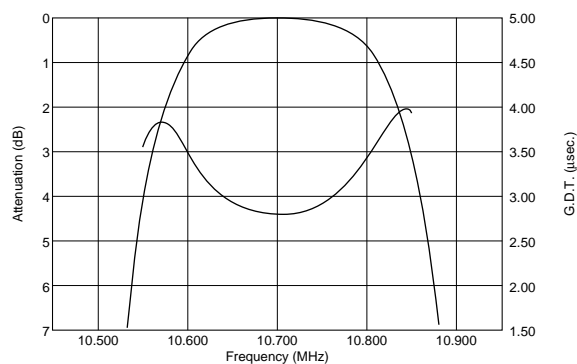
SFELA10M7HAB0-B0



SFELA10M7GAB0-B0

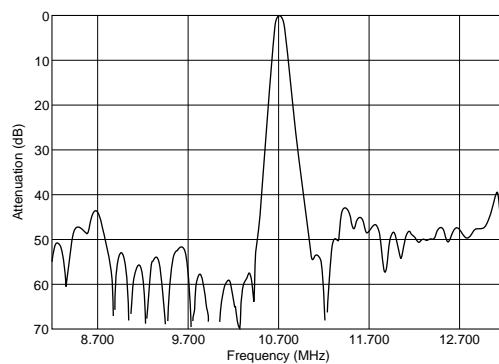


SFELA10M7FAB0-B0

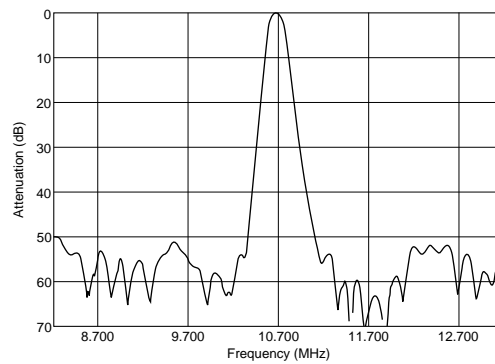


Frequency Characteristics (Spurious)

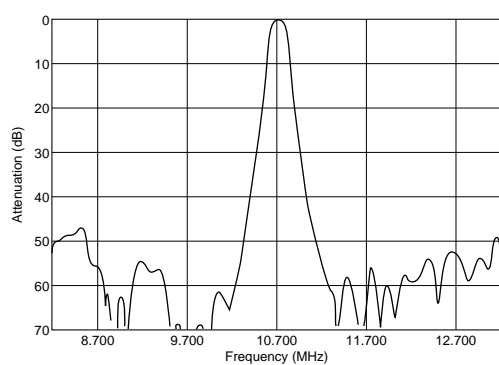
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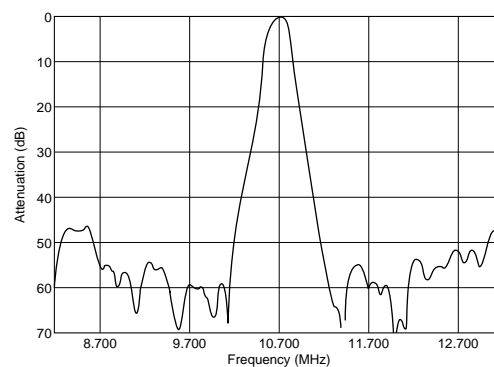
SFELA10M7JAB0-B0



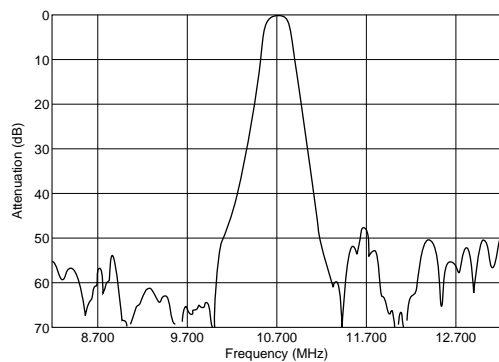
SFELA10M7HAB0-B0



SFELA10M7GAB0-B0



SFELA10M7FAB0-B0



Ceramic Filters (CERAFIL[®]) for FM Receivers



CERAFIL[®] Wider Band-width Type

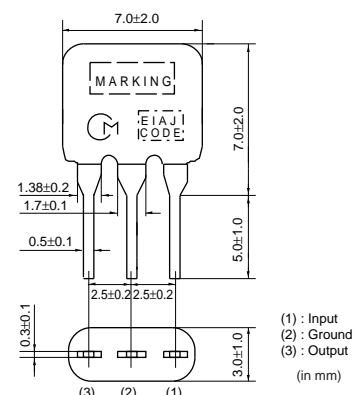
SFELA10M7 Series for FM-receivers are monolithic type ceramic filters which use the energy trapped thickness vibration-mode of the piezoelectric ceramic.

■ Features

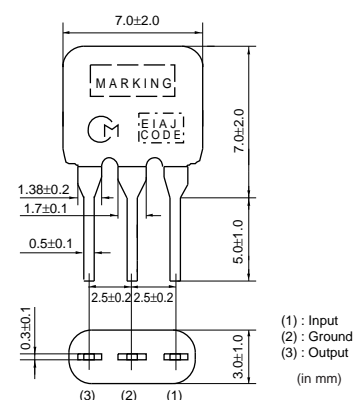
1. Realizes wider or narrower band characteristics not obtained by conventional ceramic filters.
2. Temperature characteristics are the best available, the same as those of Murata's conventional ceramic filters. Thus, even in the case of narrow band filters, the center frequency is stable even if temperature changes.



SFELA10M7EA00-B0



SFELA10M7DF00-B0



Part Number	Center Frequency (fo) (MHz)	Nominal Center Frequency(fn) (MHz)	3dB Bandwidth (kHz)	Attenuation (kHz)	Insertion Loss (dB)	Spurious Attenuation (dB)
SFELA10M7EA00-B0	10.700 ±30kHz	-	within 330 ±50kHz	680 max.	within 4.0 ±2.0dB	30 min.
SFELA10M7DF00-B0	-	10.700	fn±175 min.	950 max.	within 3.0 ±2.0dB	20 min.

Area of Attenuation : [within 20dB] Area of Spurious Attenuation : [within 9MHz to 12MHz]

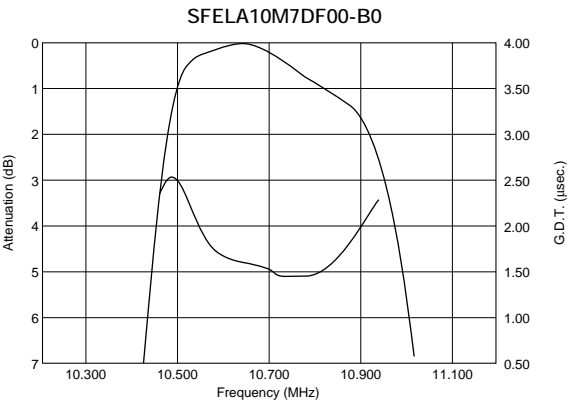
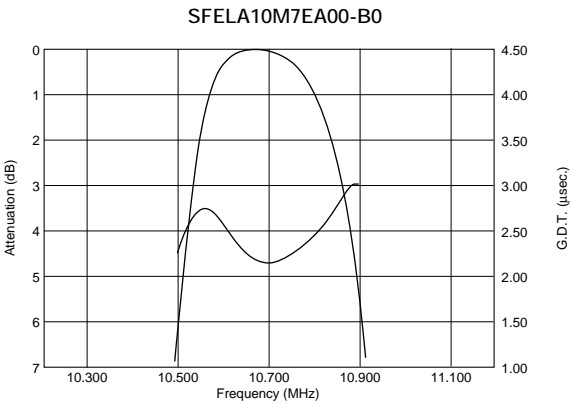
Center frequency(fo) defined by the center of 3dB bandwidth.

(fn) means nominal center frequency.

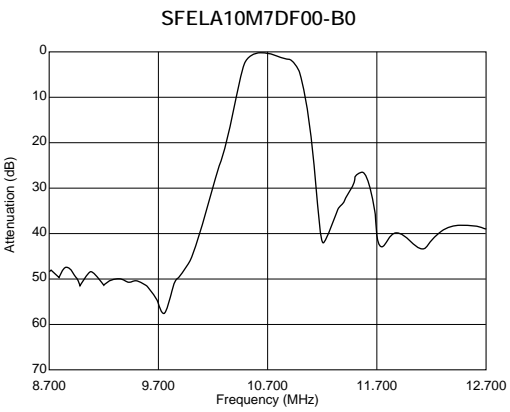
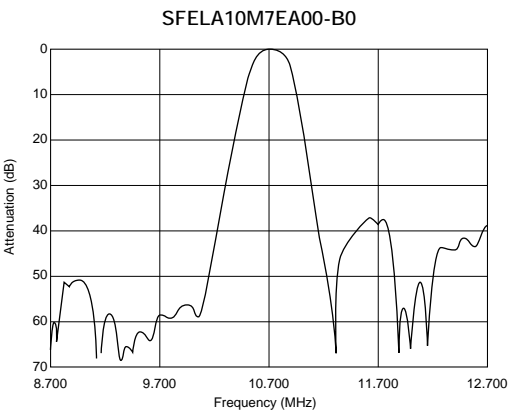
■ Center Frequency Rank Code

CODE	30kHz Step	25kHz Step
D	10.64MHz±30kHz	10.650MHz±25kHz
B	10.67MHz±30kHz	10.675MHz±25kHz
A	10.70MHz±30kHz	10.700MHz±25kHz
C	10.73MHz±30kHz	10.725MHz±25kHz
E	10.76MHz±30kHz	10.750MHz±25kHz
Z	Combination A,B,C,D,E	
M	Combination A,B,C	

Frequency Characteristics



Frequency Characteristics (Spurious)



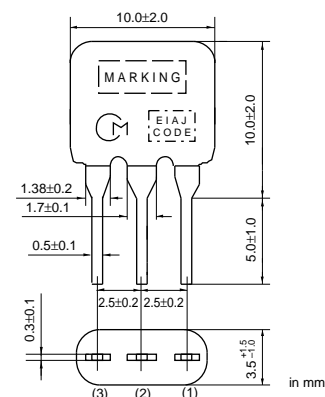
Ceramic Filters (CERAFIL[®]) for FM Receivers



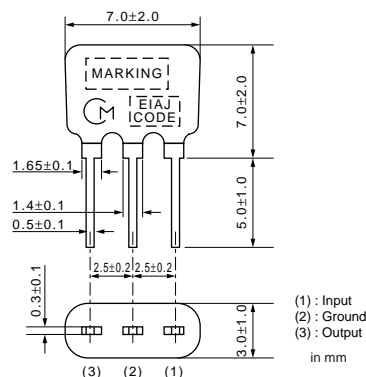
CERAFIL[®] Narrow Band Type

SFELA10M7LFTA/KAH0, SFVLA/SFKLA series realizes narrower band characteristics not obtained by conventional ceramic filters. Besides, low spurious and temperature characteristics is stable. This series suits for European car-audio or AM up conversion use that needs narrow band characteristics.

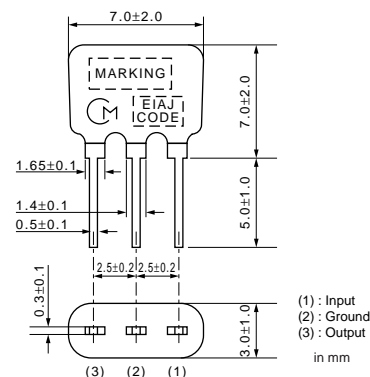
SFKLA10M7NF00-B0



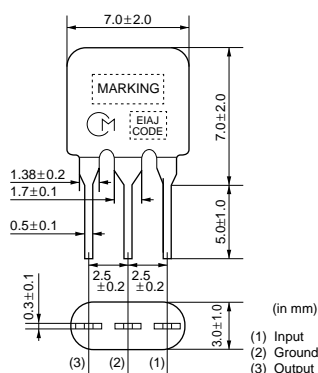
SFVLA10M7MF00-B0



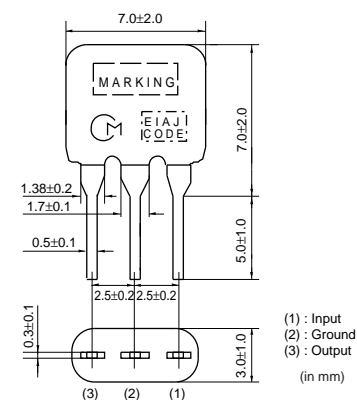
SFVLA10M7LF00-B0



SFELA10M7LFTA01-B0



SFELA10M7KAH0-B0



Part Number	Center Frequency (fo) (MHz)	Nominal Center Frequency(fn) (MHz)	3dB Bandwidth (kHz)	Attenuation (kHz)	Insertion Loss (dB)	Spurious Attenuation (dB)
SFKLA10M7NF00-B0	10.700 ±15kHz	-	20 min.	95 max.	6.0 max.	24 min.
SFVLA10M7MF00-B0	-	10.700	fn±13 min.	135 max.	within5.5 ±2.5dB	30 min.
SFVLA10M7LF00-B0	-	10.700	fn±25 min.	200 max.	within5.5 ±2.5dB	30 min.
SFELA10M7LFTA-B0	-	10.700	fn±25 min.	280 max.	within7.0 ±2.0dB	30 min.
SFELA10M7KAH0-B0	10.700 ±30kHz	-	within110 ±30kHz	350 max.	within7.0 ±2.0dB	30 min.

Area of Attenuation : [within 20dB]

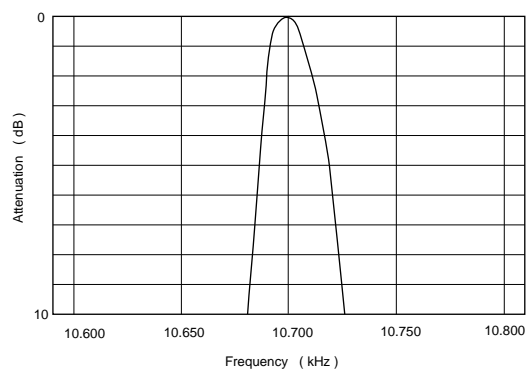
Area of Spurious Attenuation : [within 9MHz to 12MHz]

Center Frequency Rank Code

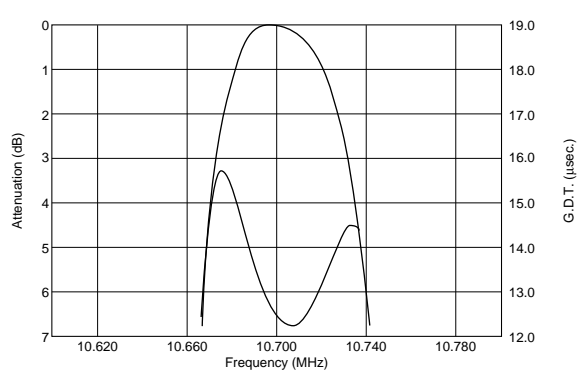
CODE	30kHz Step	25kHz Step
D	10.64MHz±30kHz	10.650MHz±25kHz
B	10.67MHz±30kHz	10.675MHz±25kHz
A	10.70MHz±30kHz	10.700MHz±25kHz
C	10.73MHz±30kHz	10.725MHz±25kHz
E	10.76MHz±30kHz	10.750MHz±25kHz
Z	Combination A,B,C,D,E	
M	Combination A,B,C	

Frequency Characteristics

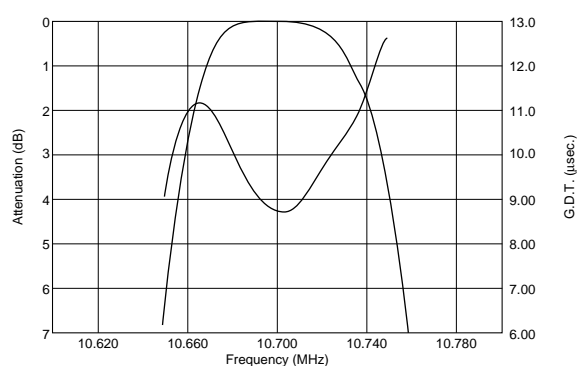
SFKLA10M7NF00-B0



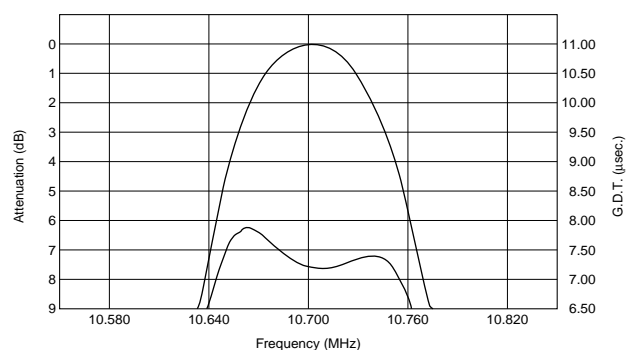
SFVLA10M7MF00-B0



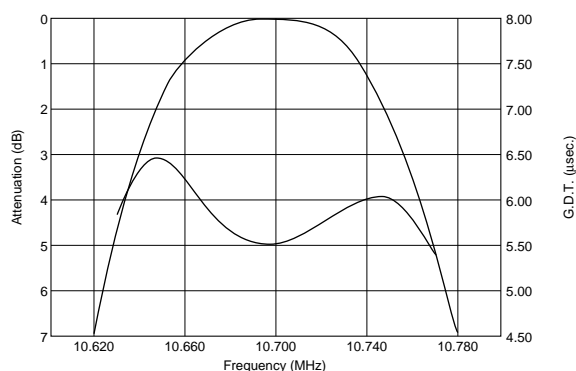
SFVLA10M7LF00-B0



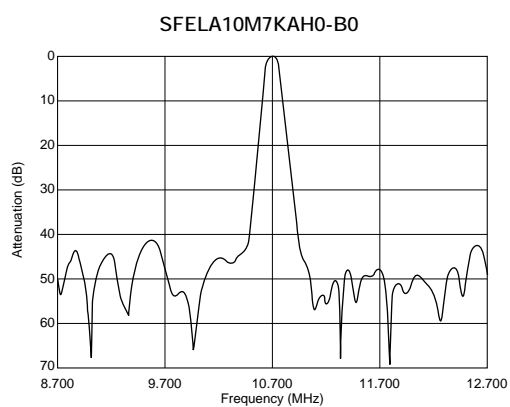
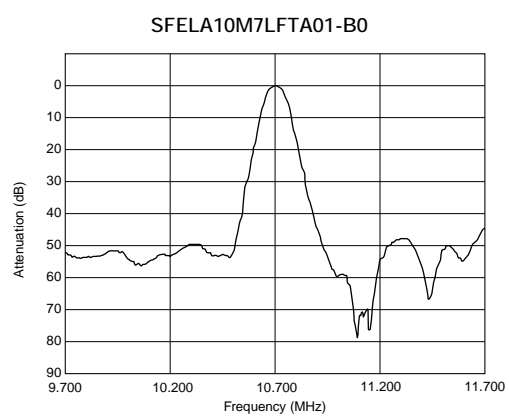
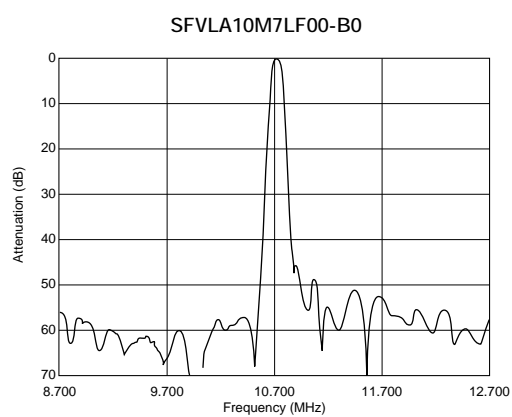
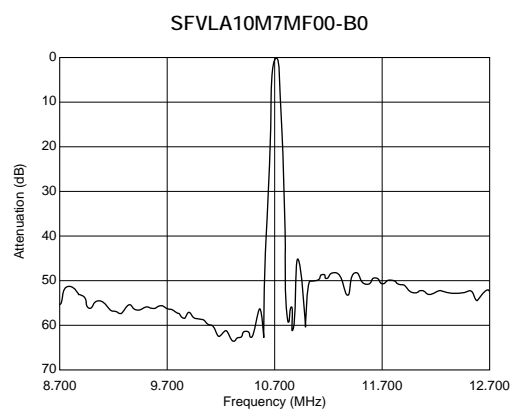
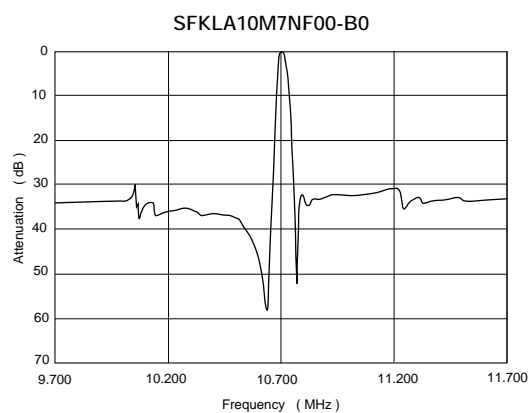
SFELA10M7LFTA01-B0



SFELA10M7KAH0-B0



■ Frequency Characteristics (Spurious)



Ceramic Filters (CERAFIL[®]) for FM Receivers



CERAFIL[®] For FM -IF Tuners

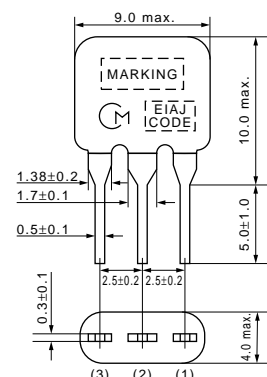
SFELA10M7 series for FM-receivers are monolithic type ceramic filters which use the energy trapped thickness vibration-mode of the piezoelectric ceramic.

■ Features

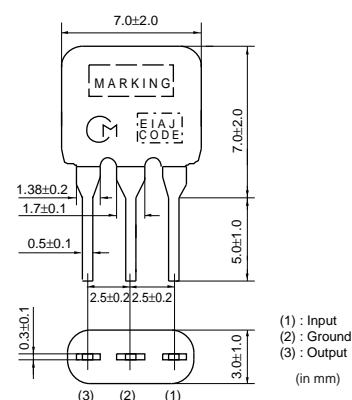
1. Little dispersion of amplitude characteristics and phase characteristics (G. D. T. characteristics).
2. The SFELA10M7G_X series has G. D. T characteristics and is useful for obtaining low distortion. SFELA10M7F_L series, in these ceramic filters, being in harmony with flatness of G. D. T. , roundness of the amplitude and selectivity characteristics, therefore, these ceramic filters are suitable to high-grade stereo tuners. Even if mismatching condition, they can keep little distortion because of low Qm of ceramic material. The SFELA10M7FA0G series is based on SFELA10M7FA00/GA00/HA00, and it obtains high selectivity with low loss. There is little dispersion of amplitude and G. D. T. characteristics, and low distortion rate can be obtained.
3. All products are inspected for symmetry and roundness of amplitude characteristics, and the flatness of G. D. T. characteristics.



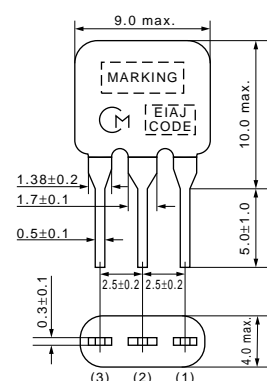
SFELA10M7JAXE-B0



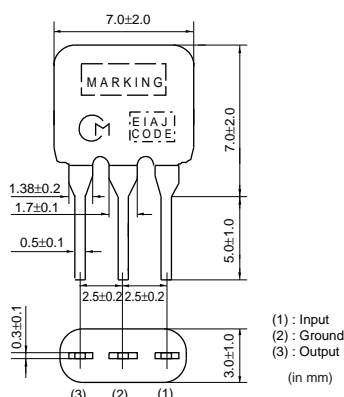
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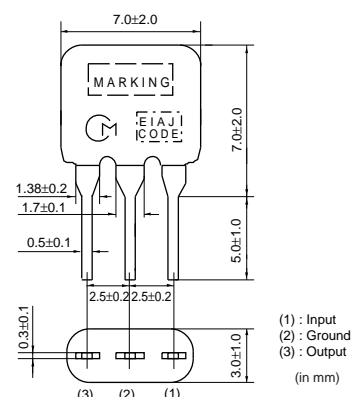
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SFELA10M7GA0G-B0



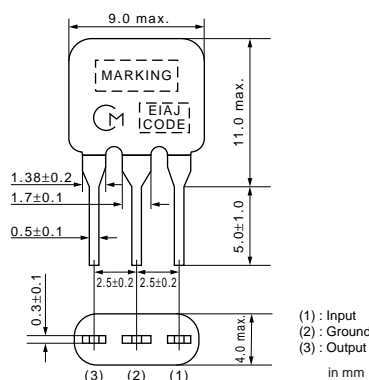
SFELA10M7GALM-B0



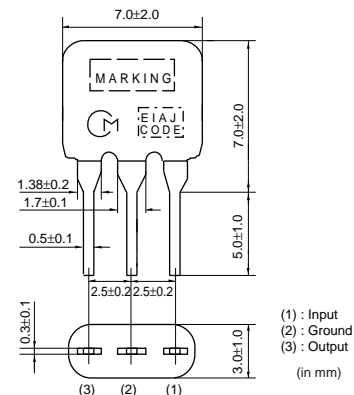
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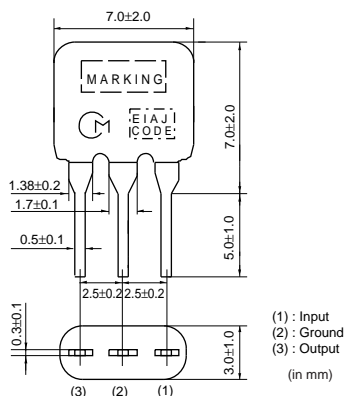
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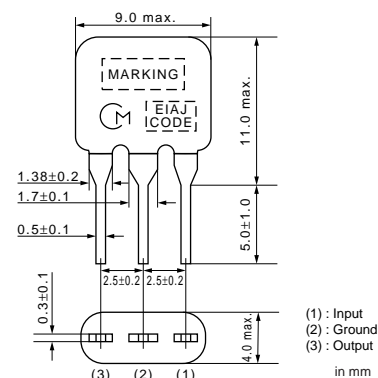
SFELA10M7FA0G-B0



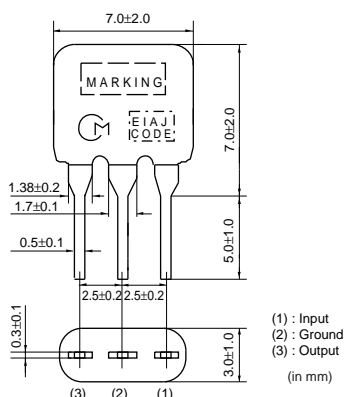
SFELA10M7GALP03-B0



SFELA10M7GAXX-B0



SFELA10M7FALL-B0



Part Number	Center Frequency (fo) (MHz)	3dB Bandwidth (kHz)	Attenuation (kHz)	Insertion Loss (dB)	Spurious Attenuation (dB)	GDT Bandwidth (kHz)
SFELA10M7JAXE-B0	10.700 ±30kHz	within150 ±30kHz	500 max.	14.0 max.	35 min.	fo±50 min.[within 0.15μsec.]
SFELA10M7HA0G-B0	10.700 ±30kHz	within180 ±40kHz	520 max.	7.0 max.	40 min.	fo±45 min.[within 0.5μsec.]
SFELA10M7HAXD-B0	10.700 ±30kHz	within180 ±30kHz	530 max.	14.0 max.	33 min.	fo±60 min.[within 0.15μsec.]
SFELA10M7GA0G-B0	10.700 ±30kHz	within230 ±50kHz	600 max.	7.0 max.	40 min.	fo±60 min.[within 0.5μsec.]
SFELA10M7GALM-B0	10.700 ±30kHz	within230 ±50kHz	600 max.	within9.0 ±2.0dB	30 min.	fo±60 min.[within 0.25μsec.]
SFELA10M7GAXA-B0	10.700 ±30kHz	within220 ±40kHz	610 max.	12.5 max.	30 min.	fo±80 min.[within 0.15μsec.]
SFELA10M7FA0G-B0	10.700 ±30kHz	within280 ±50kHz	650 max.	within4.0 ±2.0dB	30 min.	fo±85 min.[within 0.5μsec.]
SFELA10M7GALP03-B0	10.700 ±30kHz	within250 ±50kHz	650 max.	10.0 max.	30 min.	fo±65 min.[within 0.25μsec.]
SFELA10M7GAXX-B0	10.700 ±30kHz	within250 ±40kHz	670 max.	12.0 max.	25 min.	fo±110 min.[within 0.2μsec.]
SFELA10M7FALL-B0	10.700 ±30kHz	within280 ±50kHz	700 max.	within7.0 ±2.0dB	25 min.	fo±70 min.[within 0.25μsec.]

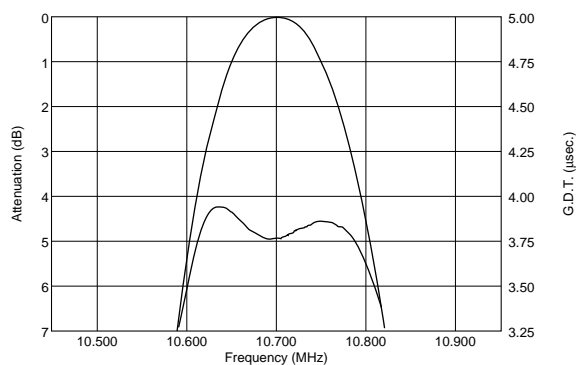
Area of Attenuation : [within 20dB] Area of Spurious Attenuation : [within 9MHz to 12MHz]
Center frequency(fo) defined by the center of 3dB bandwidth.

Center Frequency Rank Code

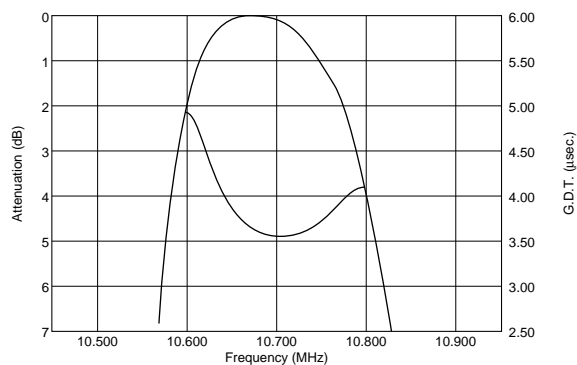
CODE	30kHz Step	25kHz Step
D	10.64MHz±30kHz	10.650MHz±25kHz
B	10.67MHz±30kHz	10.675MHz±25kHz
A	10.70MHz±30kHz	10.700MHz±25kHz
C	10.73MHz±30kHz	10.725MHz±25kHz
E	10.76MHz±30kHz	10.750MHz±25kHz
Z	Combination A,B,C,D,E	
M	Combination A,B,C	

Freq. Characteristics

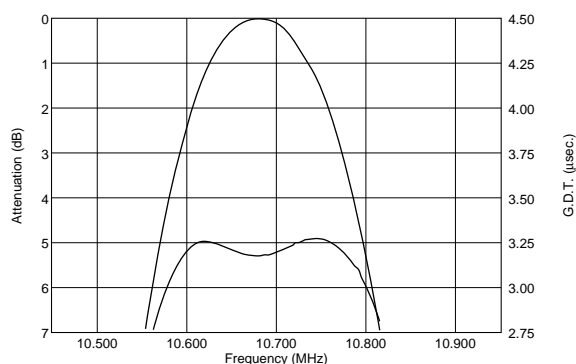
SFELA10M7JAXE-B0



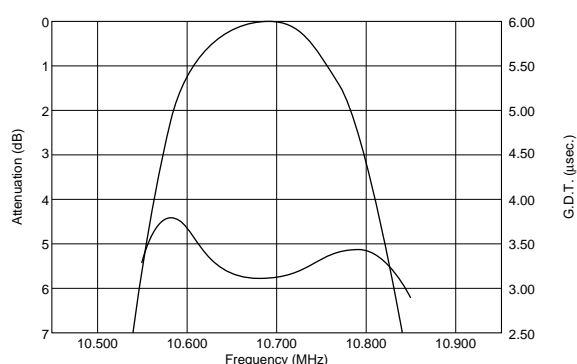
SFELA10M7HA0G-B0



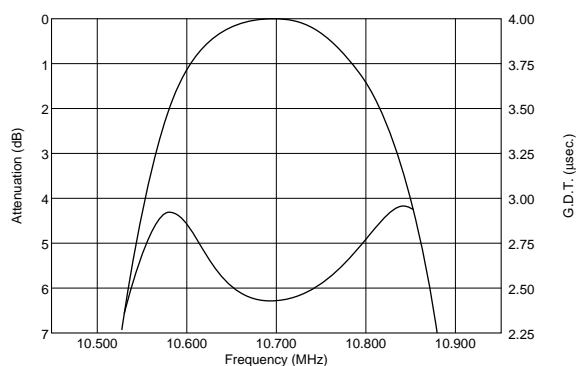
SFELA10M7HAXD-B0



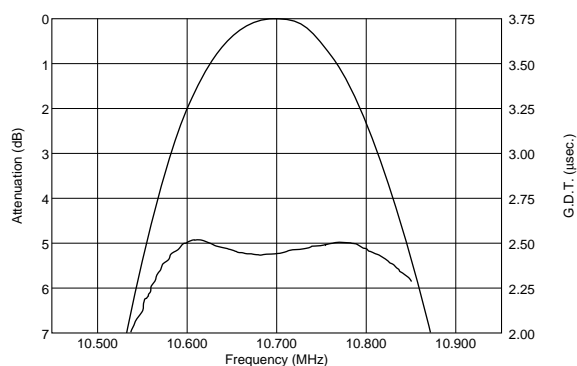
SFELA10M7GA0G-B0



SFELA10M7GALM-B0



SFELA10M7GAXA-B0

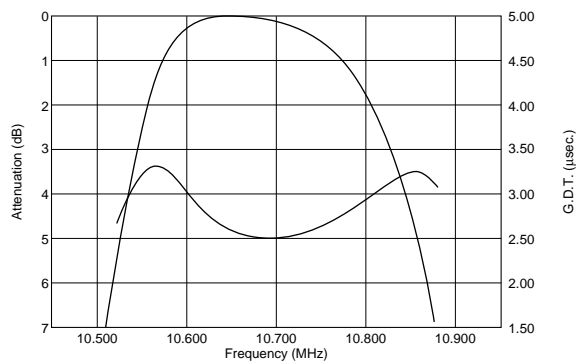


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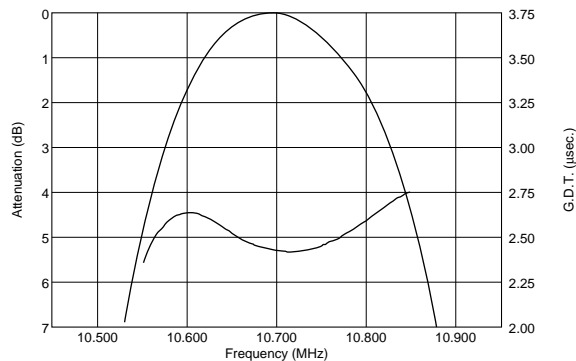
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Freq. Characteristics

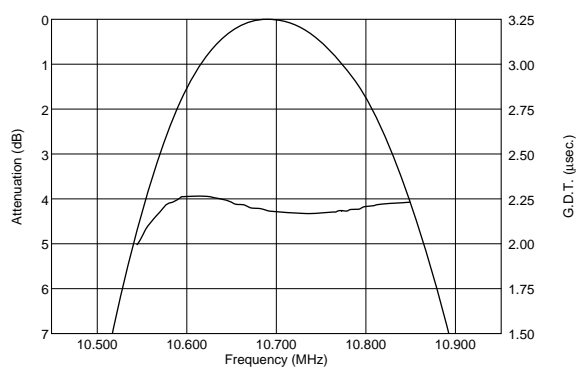
SFELA10M7FA0G-B0



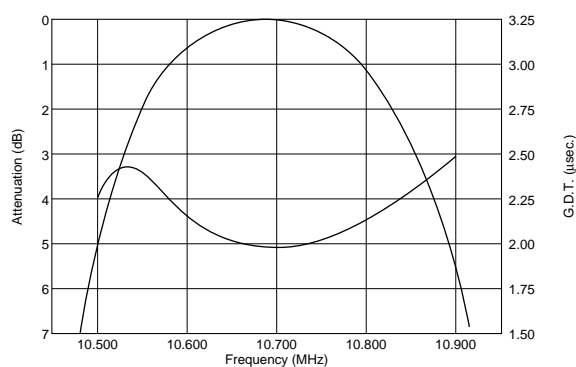
SFELA10M7GALP03-B0



SFELA10M7GAXX-B0

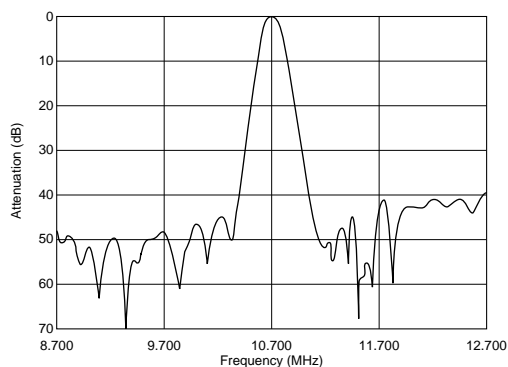


SFELA10M7FALL-B0

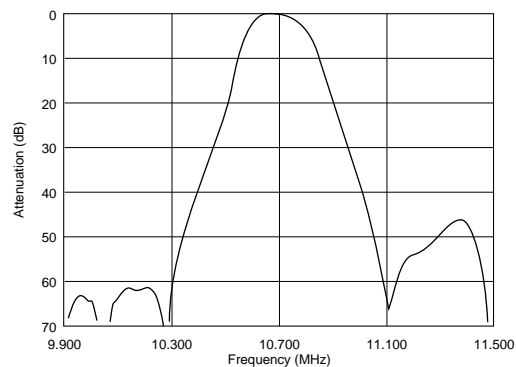


Spurious Frequency

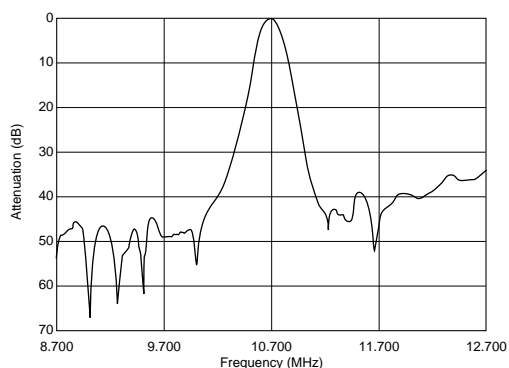
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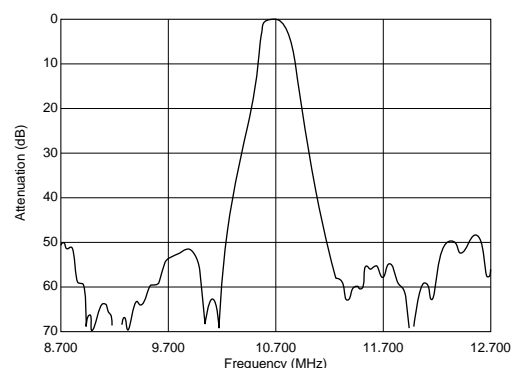
SFELA10M7HA0G-B0



SFELA10M7HAXD-B0



SFELA10M7GA0G-B0

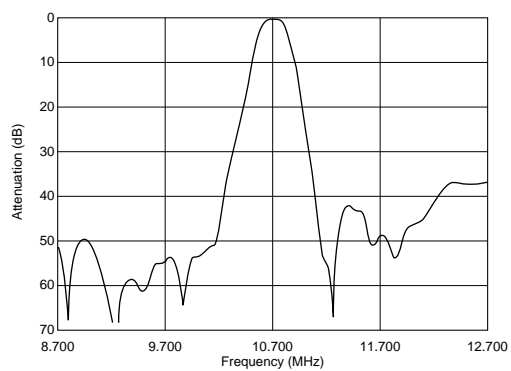


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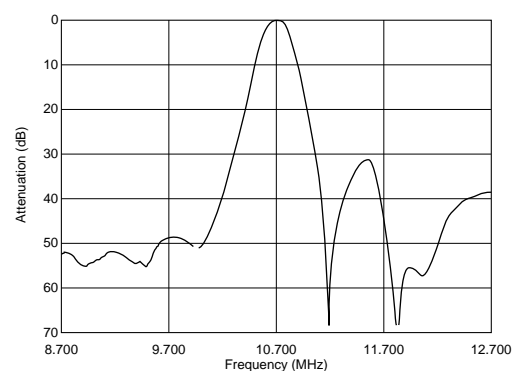
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Spurious Frequency

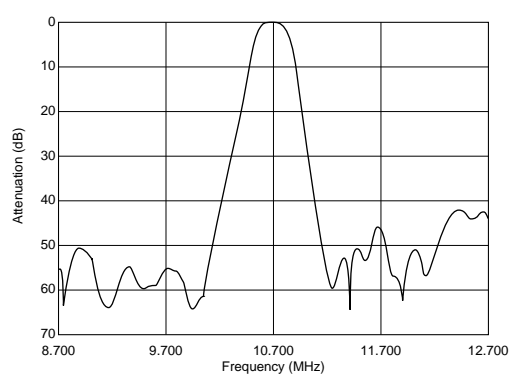
SFELA10M7GALM-B0



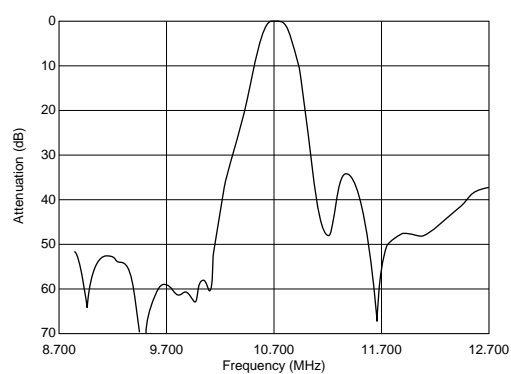
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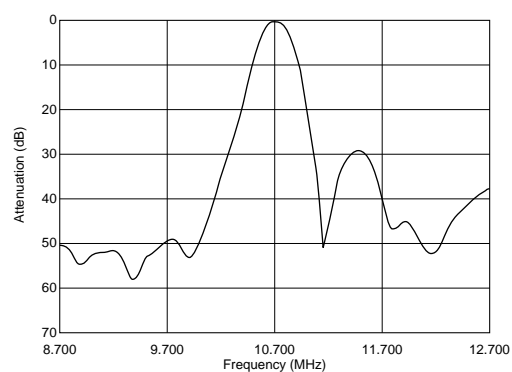
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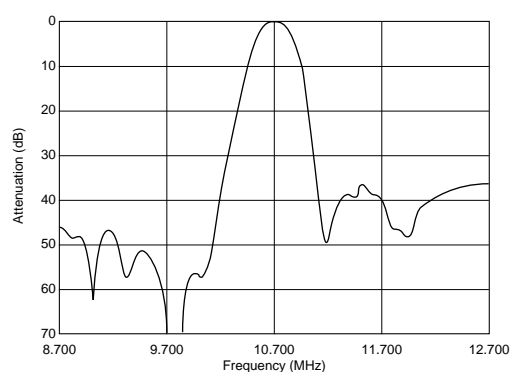
SFELA10M7GALP03-B0



SFELA10M7GAXX-B0



SFELA10M7FALL-B0



Ceramic Filters (CERAFIL[®]) for FM Receivers



CERAFIL[®] Three-Elements Type SFTLA Series

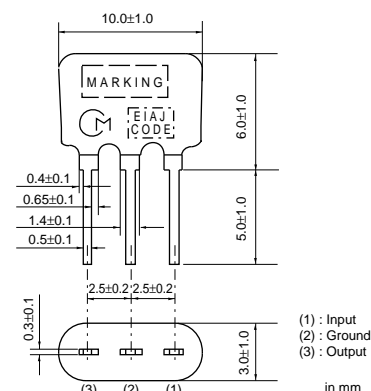
SFTLA10M7 series for FM-receivers are monolithic type ceramic filters which use the energy trapped thickness vibration-mode of the piezoelectric ceramic.

■ Features

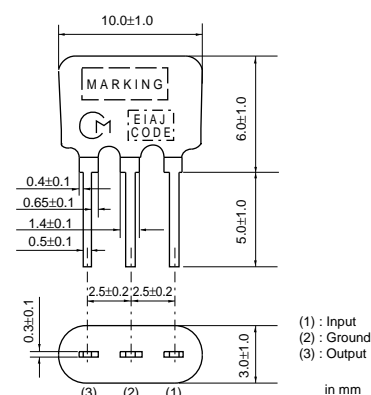
1. It has an excellent shape factor, and it is possible to obtain 1.5 times more excellent selectivity than SFELA10M7 series (by detuning ± 300 or 400kHz).
2. Good performance of spurious suppression.
3. Having the same terminal pitch as the SFELA10M7 series, it easily replaces that series.
4. By replacing two SFELA10M7 series filters with one SFTLA10M7 filter, more compact sets can be made.
5. Well-suited for 1-chip ICs.



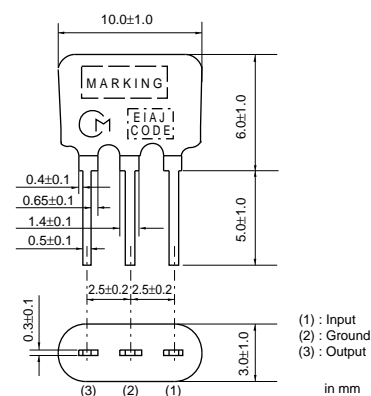
SFTLA10M7HA00-B0



SFTLA10M7GA00-B0



SFTLA10M7FA00-B0



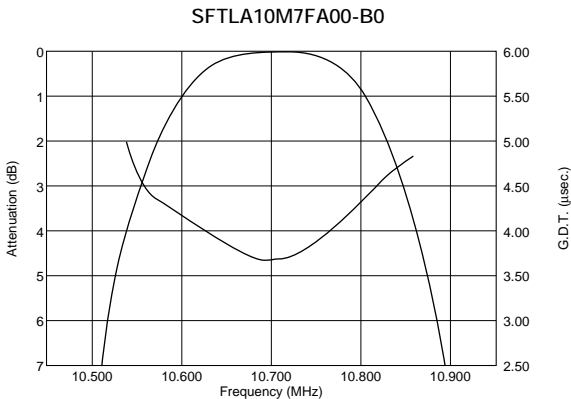
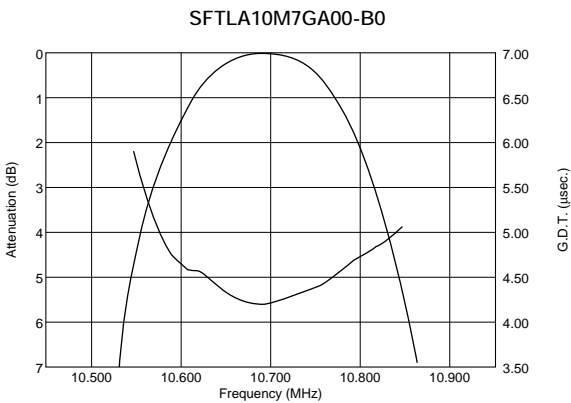
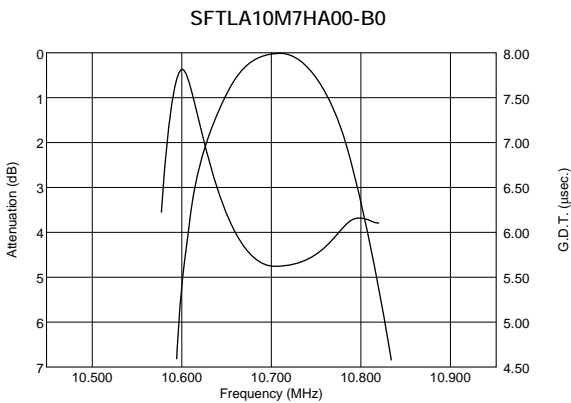
Part Number	Center Frequency (fo) (MHz)	3dB Bandwidth (kHz)	Attenuation (kHz)	Insertion Loss (dB)	Spurious Attenuation (dB)
SFTLA10M7HA00-B0	10.700 ±30kHz	within 180 ±40kHz	550 max.	within 5.5 ±2.5dB	50 min.
SFTLA10M7GA00-B0	10.700 ±30kHz	within 230 ±40kHz	650 max.	within 6.0 ±2.0dB	50 min.
SFTLA10M7FA00-B0	10.700 ±30kHz	within 280 ±50kHz	700 max.	within 6.0 ±2.0dB	50 min.

Area of Attenuation : [within 40dB] Area of Spurious Attenuation : [within 9MHz to 12MHz]
 Center frequency(fo) defined by the center of 3dB bandwidth.

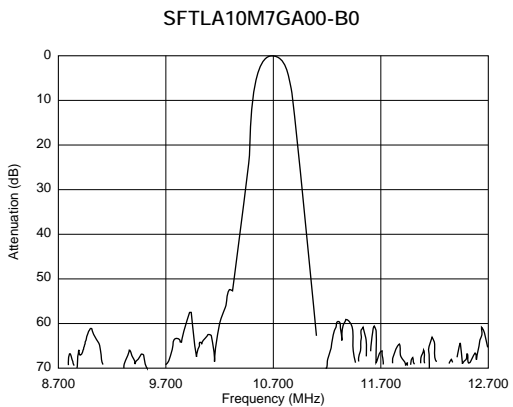
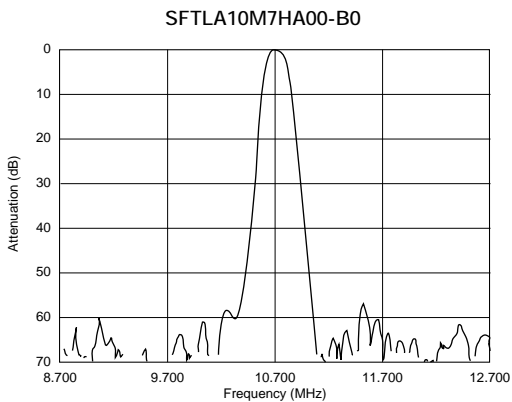
Center Frequency Rank Code

CODE	30kHz Step	25kHz Step
D	10.64MHz±30kHz	10.650MHz±25kHz
B	10.67MHz±30kHz	10.675MHz±25kHz
A	10.70MHz±30kHz	10.700MHz±25kHz
C	10.73MHz±30kHz	10.725MHz±25kHz
E	10.76MHz±30kHz	10.750MHz±25kHz
Z	Combination A,B,C,D,E	
M	Combination A,B,C	


Frequency Characteristics



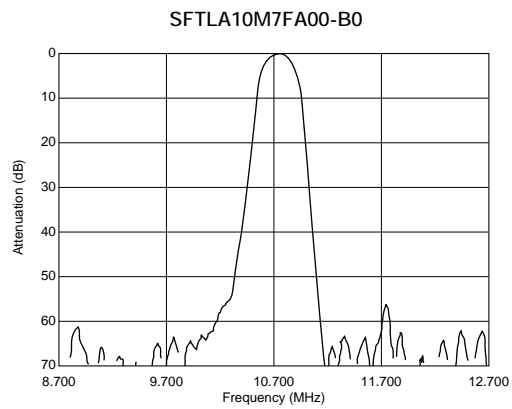
Frequency Characteristics (Spurious)



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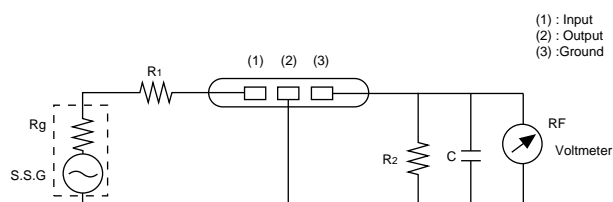
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■ Frequency Characteristics (Spurious)



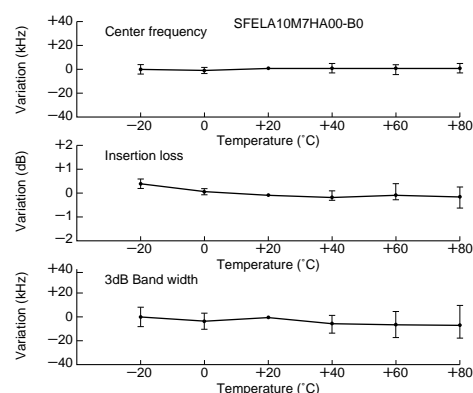
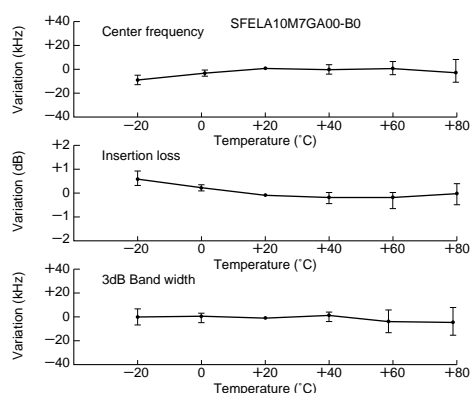
Lead Type CERAFIL[®] Test Circuit and Characteristics Data

■ Test Circuit



$R_g + R_1 = R_2 = 330\Omega$
 $C = 10\text{pF}$ (Including stray capacitance and input capacitance of RF voltmeter.)

■ Temperature Characteristics



■ Matching Conditions

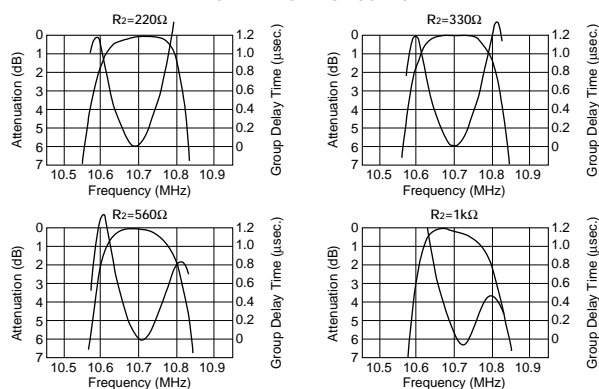
- When using ceramic filters, it is most important to match the input/output load to impedance 330 ohm (only SFELA10M7DF00-B0 is 470 ohm matching). Waveform symmetry is damaged when reactance is added to the input/output load.
- Two ceramic filters directly connected can be used for high selectivity. For reducing waveform variation, it is recommended to input a buffer AMP between ceramic filters.

- The SFELA10M7 and SFTLA10M7 series are of input/output symmetric structure so that in theory there is no input/output directionality. Actual circuits may use different input/output loading conditions (for example, mismatched impedance) or capacitance load. In such cases, the waveform will be a little changed by the direction of the input/output of the ceramic filters.

Lead Type CERAFIL® Characteristics Data and Notice

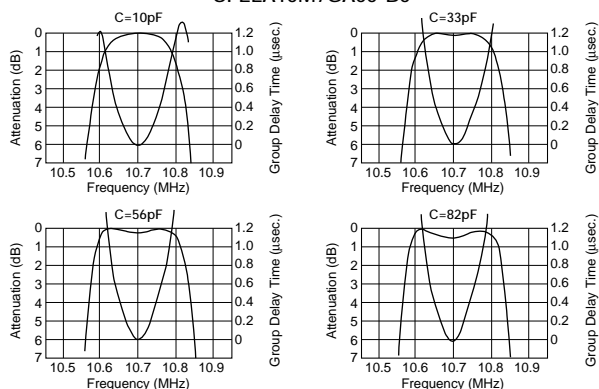
■ Loaded Resistance and Waveform ($R_g + R_1 = 330\Omega$)

SFELA10M7GA00-B0



■ Loaded Capacitance and Waveform ($R_g + R_1 = R_2 = 330\Omega$)

SFELA10M7GA00-B0



■ Notice (Soldering and Mounting)

The component cannot be withstand washing.

■ Notice (Handling)

1. Do not use this product with bend. The component may be damaged if excess mechanical stress is applied to it mounted on the printed circuit board.
2. The component may be damaged when an excess stress will be applied.
3. All kinds of re-flow soldering must not be applied on the component.
4. Do not clean or wash the component as it is not hermetically sealed.
5. Do not use strong acidity flux, more than 0.2wt% chlorine content, in flow soldering.
6. In case of covering discriminator with over coat, conditions such as material of resin, cure temperature, and so on should be evaluated well.
7. Accurate test circuit values are required to measure electrical characteristics. It may be a cause of mis-correlation if there is any deviation, especially stray capacitance, from the test circuit in the specification.

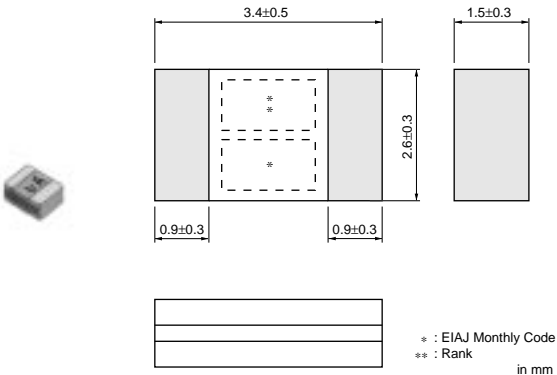
Ceramic Filters (CERAFIL®) for FM Receivers

Discriminators Chip Type CDACV Series

CDACV10M7 series forms a resonator on a piezoelectric ceramic substrate. In combination with ICs, this type obtains stable demodulation characteristics in wide bandwidths.

■ Features

- 1. Compact and excellent mechanical strength.
- 2. Can be combined with various ICs. The IC is determined by the last number in the part number.
- 3. Stable demodulation characteristics can be obtained without adjustment.
- 4. The MG type for wide bandwidths and the MC type for narrow bandwidths are available.
- 5. Stable temperature characteristics.
- 6. We recommend kits : ceramic discriminator CDACV10M7 series and "CERAFIL" SFECV10M7 of the same frequency rank.

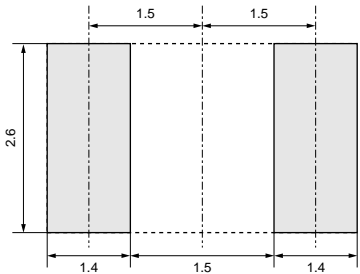


Part Number	Center Frequency (fo) (MHz)	Recovered Audio 3dB BW (kHz)	Recovered Audio Output (mV)	Distortion (%)	IC	Detection Method
CDACV10M7GA001-R0	10.700 ±30kHz	fo±150 min.	55 min.	1.0 max.	CX20029	Quadrature
CDACV10M7GA016-R0	10.700 ±30kHz	300 min.	within60 to 90mV	0.9 max.	TA8122F	Quadrature
CDACV10M7GA046-R0	10.700 ±30kHz	330 min.	280 min.	1.5 max.	LA1832	Quadrature
CDACV10M7GA069-R0	10.700 ±30kHz	330 min.	80 min.	1.0 max.	CXA1538N	Quadrature
CDACV10M7CA001-R0	10.700 ±30kHz	fo±150 min.	55 min.	1.0 max.	CX20091	Quadrature

■ Center Frequency Rank Code

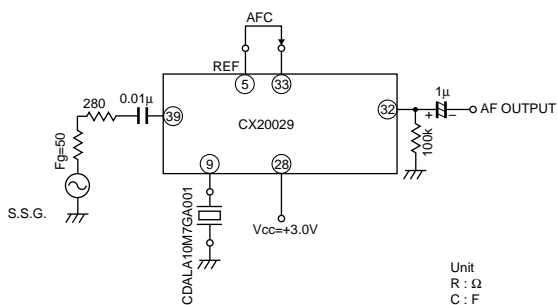
CODE	30kHz Step	25kHz Step
D	10.64MHz±30kHz	10.650MHz±25kHz
B	10.67MHz±30kHz	10.675MHz±25kHz
A	10.70MHz±30kHz	10.700MHz±25kHz
C	10.73MHz±30kHz	10.725MHz±25kHz
E	10.76MHz±30kHz	10.750MHz±25kHz
Z	Combination A,B,C,D,E	
M	Combination A,B,C	

■ Standard Land Pattern Dimensions

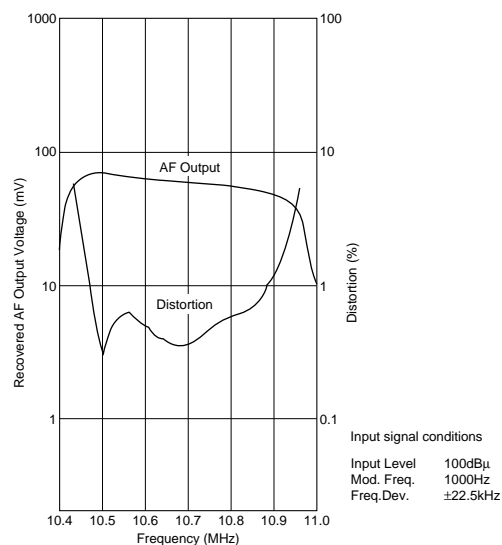


■ CDACV10M7GA001-R0

Test Circuit

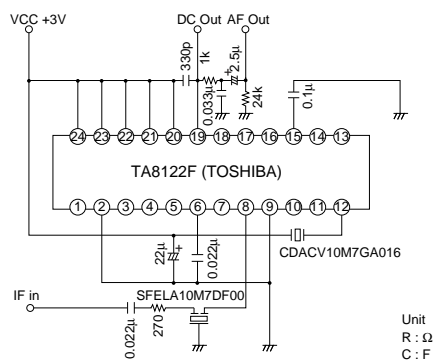


Frequency Characteristics

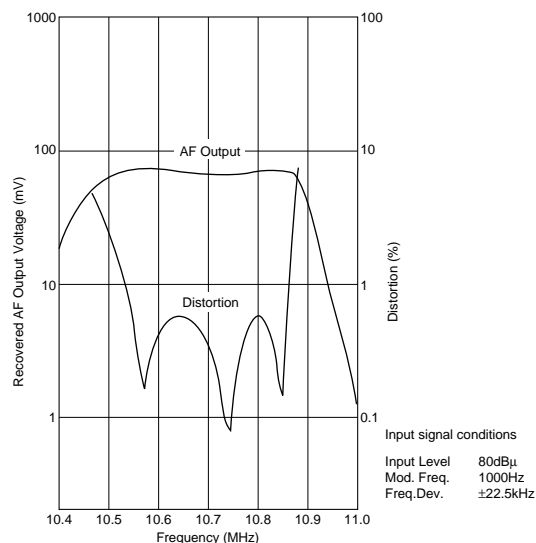


■ CDACV10M7GA016-R0

Test Circuit

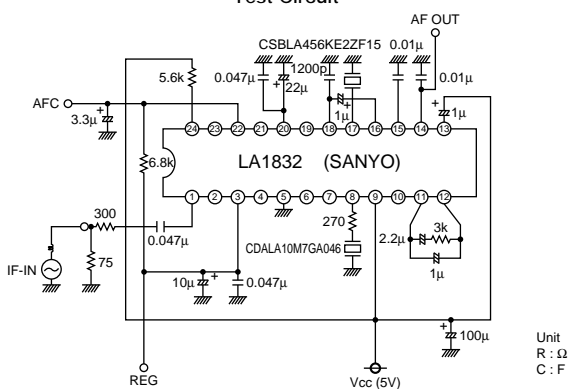


Frequency Characteristics

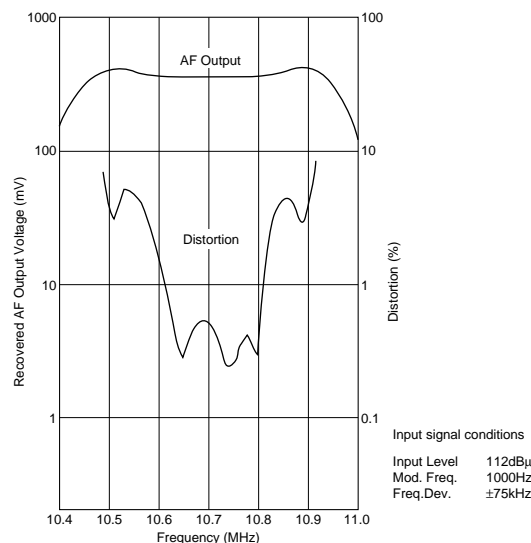


■ CDACV10M7GA046-R0

Test Circuit



Frequency Characteristics

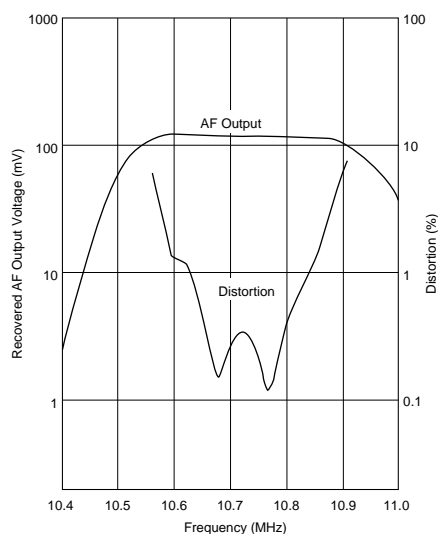


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■ CDACV10M7GA069-R0

■ CDACV10M7GA069-R0

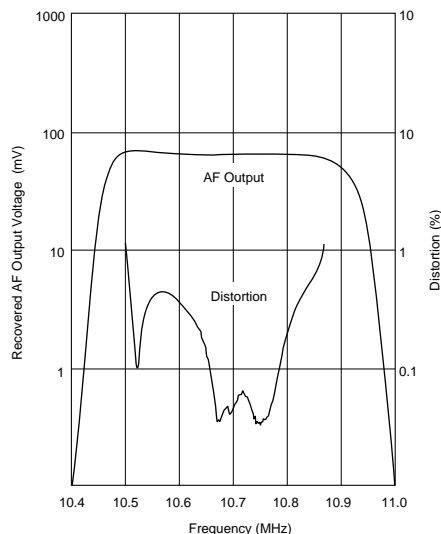
Frequency Characteristics



Input signal conditions	
Input Level	100dB μ
Mod.Freq.	1000Hz
Freq.Dev.	± 75 kHz

■ CDACV10M7CA001-R0

Frequency Characteristics



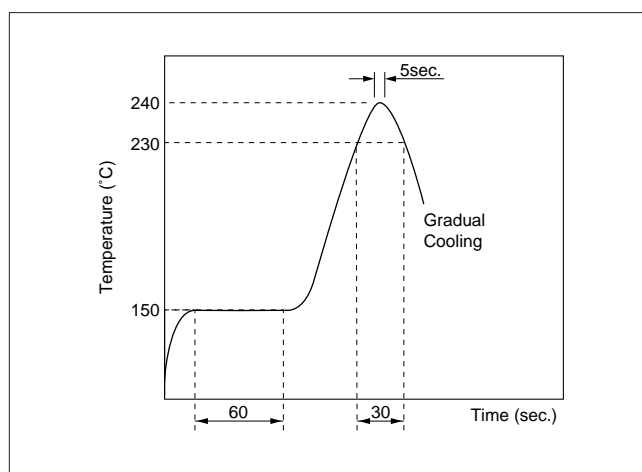
Input signal conditions	
Input Level	100dB μ
Mod.Freq.	1000Hz
Freq.Dev.	± 22.5 kHz

Chip Type Discriminators CDACV Series Notice

■ Notice (soldering and mounting)

1. Standard Reflow Soldering Condition

(1) Reflow



(2) Soldering Iron

Lead terminal is directly contacted with the tip of soldering iron of $280 \pm 5^\circ\text{C}$ for 3.0 ± 0.5 seconds.

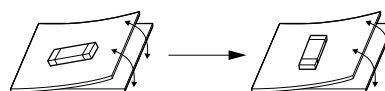
2. Wash

The component cannot be withstand washing.

■ Notice (handling)

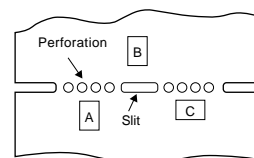
1. The component may be damaged if excess mechanical stress is applied to it mounted on the printed circuit board.
2. Design layout of components on the PC board to minimize the stress imposed on the warp or flexure of the board.
3. After installing chips, if solder is excessively applied to the circuit board, mechanical stress will cause destruction resistance characteristics to lower. To prevent this, be extremely careful in determining shape and dimension before designing the circuit board diagram.
4. When the positioning claws and pick up nozzle are worn, the load is applied to the chip while positioning is concentrated to one positioning accuracy, etc. Careful checking and maintenance are necessary to prevent unexpected trouble.
5. When correcting chips with a soldering iron, the tip of the soldering iron should not directly touch the chip component. Depending on the soldering conditions, the effective area of terminations may be reduced. the use of solder containing Ag should be done to prevent the electrode erosion.
6. Do not clean or wash the component as it is not hermetically sealed.
7. In case of covering discriminator with over coat, conditions such as material of resin, cure temperature, and so on should be evaluated well.
8. Accurate test circuit values are required to measure electrical characteristics.
It may be a cause of mis-correlation if there is any deviation, especially stray capacitance, from the test circuit in the specification.

[Component direction]



Put the component lateral to the direction in which stress acts.

[Component layout close to board]



Susceptibility to stress is in the order of : $A > C > B$

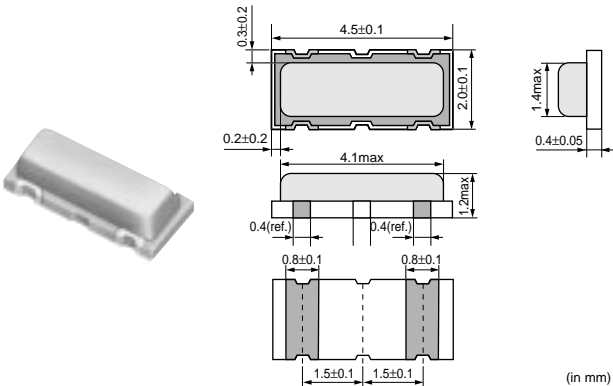
Ceramic Filters (CERAFIL®) for FM Receivers

Discriminators Chip Low-profile Type CDSCA Series

CDSCA10M7 series forms a resonator on a piezo electric ceramic substrate. In combination with ICs, this type obtains stable demoduration characteristics in wide bandwidth.

■ Features

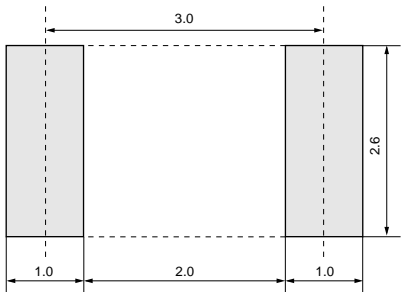
- 1. Compact and high reliability and recommended for automotive applications.
- 2. Can be combined with various ICs. The IC is determined by the last number in the part number.
- 3. Stable demoduration characteristics can be obtained without adjustment.
- 4. Stable temperature characteristics.
- 5. Recommended for Pb free soldering.



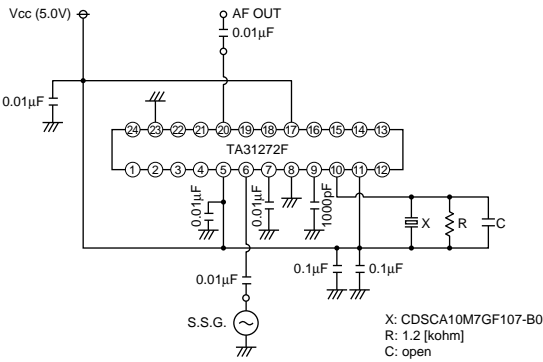
Part Number	Center Frequency (fo) (MHz)	Recovered Audio 3dB BW (kHz)	Recovered Audio Output (mV)	Distortion (%)	IC	Detection Method
CDSCA10M7GF107-R0	10.700 (fn)	fn±80 min.	52 min.	3.0 max.	TA31272F	Quadrature

(fn) means nominal center frequency.

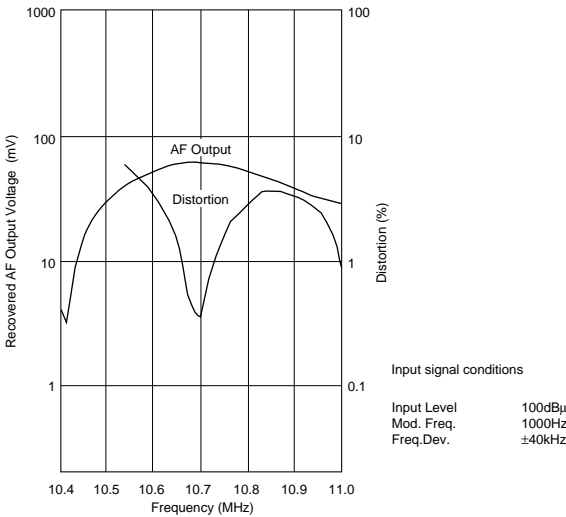
■ Standard Land Pattern Dimensions



■ Test Circuit



■ Frequency Characteristics

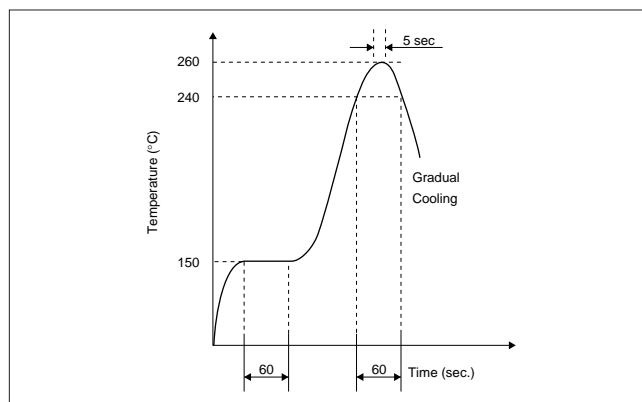


Chip Type Discriminators CDSCA Series Notice

■ Notice (Soldering and Mounting)

1. Standard Reflow Soldering Condition

(1) Reflow



(2) Soldering Iron

Lead terminal is directly contacted with the tip of soldering iron of $+280 \pm 5^\circ\text{C}$ for $3.0 \text{ seconds} \pm 0.5 \text{ seconds}$.

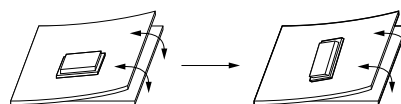
2. Wash

The component cannot be withstand washing.

■ Notice (Handling)

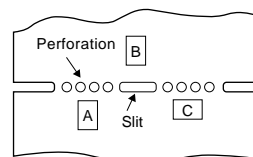
- The component mounted on the PCB may be damaged if excess mechanical stress is applied.
- Layout the components on the PCB to minimize the stress imposed by the warp or flexure of the board.
- After installing components, if solder is excessively applied to the circuit board, mechanical stress will cause destruction resistance characteristics to be lower. To prevent this, be extremely careful in determining shape and dimension before designing the circuit board diagram.
- When the positioning claw or pick up nozzle are worn, the excess load is applied to the components while positioning or placing are performed. Careful checking and maintenance are necessary to prevent unexpected trouble.
- When correcting component's position with a soldering iron, the tip of the soldering iron should not directly touch the chip component. Depending on the soldering conditions, the effective area of terminations may be reduced. The use of solder containing Ag should be considered to prevent the electrode erosion.
- Do not clean or wash the component as it is not hermetically sealed.
- In case of overcoating the part, coating conditions such as material, curing temperature, and so on must be evaluated deeply.
- Accurate test circuit values are required to measure electrical characteristics.
It may be a cause of mis-correlation if there is any deviation, especially stray capacitance, from the test circuit in the specification.

[Component direction]



Put the component laterally to the direction in which stress acts.

[Component layout close to board]



Susceptibility to stress is in the order of : $A > C > B$

Ceramic Filters (CERAFIL®) for FM Receivers

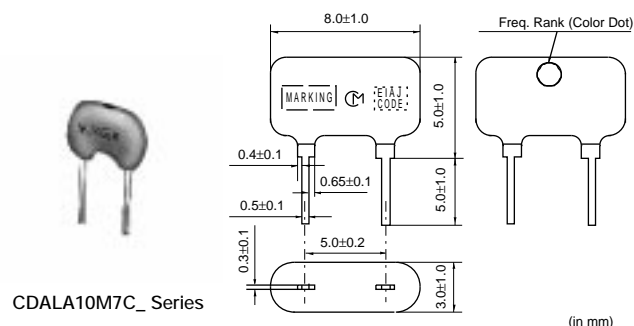
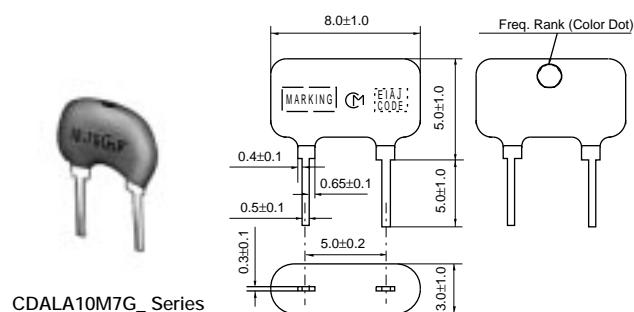


Discriminators CDALA Series

CDALA10M7 series forms a resonator on a piezoelectric ceramic substrate. In combination with ICs, this type obtains stable demodulation characteristics in wide bandwidths.

■ Features

1. Compact and excellent mechanical strength.
2. Can be combined with various ICs. The IC is determined by the last number in the part number.
3. Stable demodulation characteristics can be obtained without adjustment.
4. The MG type for wide bandwidths and the MC type for narrow bandwidths are available.
5. Stable temperature characteristics.
6. We recommend combination : ceramic discriminator CDALA10M7 series and "CERAFIL" SFELA10M7 of the same frequency rank.



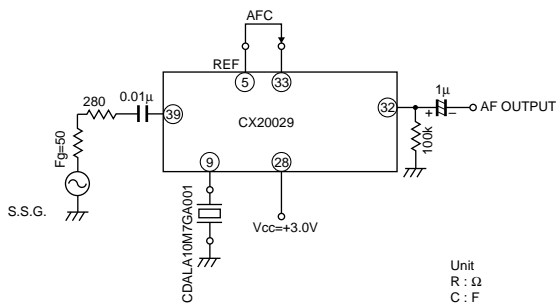
Part Number	Center Frequency (fo) (MHz)	Recovered Audio 3dB BW (kHz)	Recovered Audio Output (mV)	Distortion (%)	IC	Detection Method
CDALA10M7GA001-B0	10.700 ±30kHz	345 min.	25 min.	0.6 max.	CX20029	Quadrature
CDALA10M7GA016-B0	10.700 ±30kHz	300 min.	within 60 to 90mV	0.9 max.	TA8122F	Quadrature
CDALA10M7GA018-B0	10.700 ±30kHz	300 min.	60 min.	0.9 max.	TA8132N	Quadrature
CDALA10M7GA046-B0	10.700 ±30kHz	330 min.	280 min.	1.0 max.	LA1832	Quadrature
CDALA10M7GA048-B0	10.700 ±30kHz	400 min.	700 min.	1.0 max.	LA1835	Quadrature
CDALA10M7GA092-B0	10.700 ±30kHz	300 min.	60 min.	1.0 max.	TA2132P	Quadrature
CDALA10M7CA001-B0	10.700 ±30kHz	242 min.	35 min.	-	CX20091	Quadrature
CDALA10M7CA005A-B0	10.700 ±30kHz	100 min.	600 min.	6.0 max.	LA7770	Quadrature
CDALA10M7CA040-B0	10.700 ±30kHz	130 min.	40 min.	0.7 max.	TEA5710	Quadrature

■ Center Frequency Rank Code

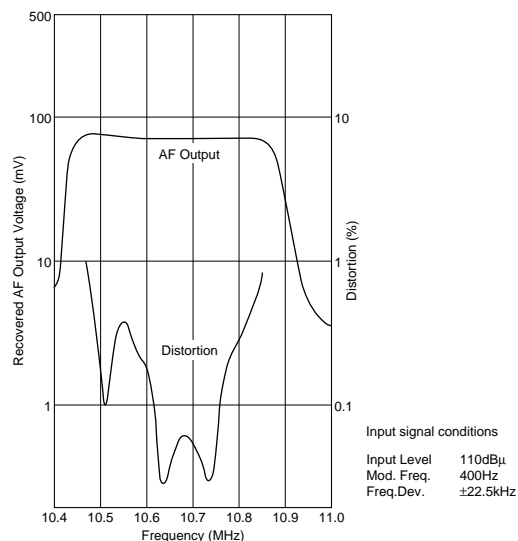
CODE	30kHz Step	25kHz Step
D	10.64MHz±30kHz	10.650MHz±25kHz
B	10.67MHz±30kHz	10.675MHz±25kHz
A	10.70MHz±30kHz	10.700MHz±25kHz
C	10.73MHz±30kHz	10.725MHz±25kHz
E	10.76MHz±30kHz	10.750MHz±25kHz
Z	Combination A,B,C,D,E	
M	Combination A,B,C	

■ CDALA10M7GA001-B0

Test Circuit

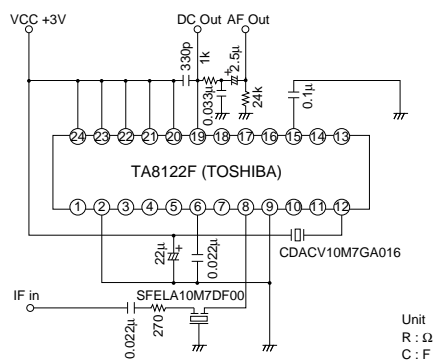


Frequency Characteristics

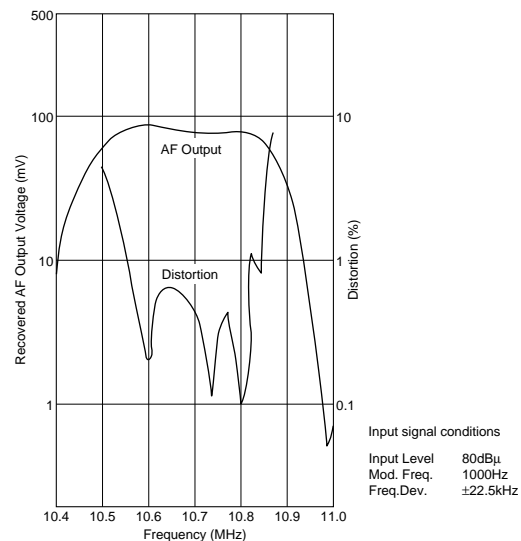


■ CDALA10M7GA016-B0

Test Circuit

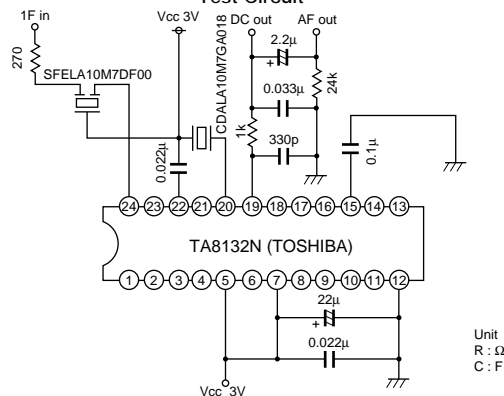


Frequency Characteristics

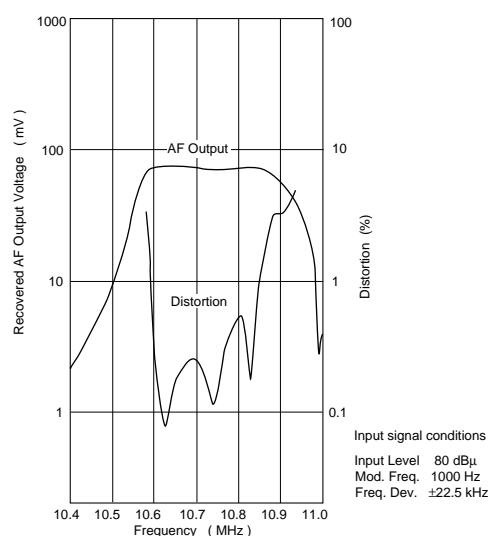


■ CDALA10M7GA018-B0

Test Circuit



Frequency Characteristics



■ CDALA10M7GA046-B0

■ CDALA10M7GA046-B0

Unit
R : Ω
C : F

The graph shows the frequency response of the AF output and distortion. The x-axis is Frequency (MHz) from 10.4 to 11.0. The left y-axis is Recovered AF Output Voltage (mV) on a log scale from 1 to 1000. The right y-axis is Distortion (%) on a log scale from 0.1 to 100. The AF Output curve is relatively flat around 400 mV. The Distortion curve shows a significant dip at 10.7 MHz, reaching approximately 0.3%.

Frequency (MHz)	Recovered AF Output Voltage (mV)	Distortion (%)
10.4	250	-
10.5	450	-
10.6	400	1.5
10.7	380	0.3
10.8	380	1.0
10.9	450	-
11.0	80	-

Input signal conditions:
 Input Level 112 dBμ
 Mod. Freq. 1000 Hz
 Freq. Dev. ±75 kHz

Input signal conditions

Input Level	112 dBμ
Mod. Freq.	1000 Hz
Freq. Dev.	±75 kHz

CDALA10M7GA048-B0

Unit
R : Ω
C : F

Recovered AF Output Voltage (mV)

Distortion (%)

AF Output

Distortion

Frequency (MHz)

Input signal conditions

Input Level	112dB μ
Mod. Freq.	1000Hz
Freq.Dev.	± 75 kHz

Input signal conditions	
Input Level	112dBμ
Mod. Freq.	1000Hz
Freq.Dev.	±75kHz

CDALA10M7GA092-B0

The schematic diagram shows the TA2132P (TOSHIBA) IC with its 16 pins. The connections are as follows:

- Pin 1:** Connected to ground.
- Pin 2:** Connected to ground.
- Pin 3:** Connected to ground.
- Pin 4:** Connected to ground via a 4.7μF capacitor.
- Pin 5:** Connected to ground via a 4.7μF capacitor.
- Pin 6:** Connected to ground via a 270Ω resistor and a 0.01μF capacitor in series.
- Pin 7:** Connected to ground.
- Pin 8:** Connected to ground.
- Pin 9:** Connected to ground.
- Pin 10:** Connected to ground.
- Pin 11:** Connected to ground.
- Pin 12:** Connected to ground.
- Pin 13:** Connected to ground.
- Pin 14:** Connected to ground.
- Pin 15:** Connected to ground.
- Pin 16:** Connected to ground.
- IF-IN:** Input signal connected to Pin 6.
- DC OUT:** Output signal connected to Pin 16.
- AF OUT:** Output signal connected to Pin 15.
- Vcc(3.0V):** Power supply connected to Pin 14.
- Other components:** A 20kΩ resistor is connected between Pin 15 and Pin 16. A 2.2μF capacitor is connected between Pin 15 and Pin 16. A 330pF capacitor is connected between Pin 15 and Pin 16. A CDALA10M7GZ092-B0 component is connected between Pin 15 and Pin 16.

Unit
R : Ω
C : F


The graph shows the frequency response of the AF output and distortion for an input level of 80dBμ. The x-axis represents Frequency in MHz, ranging from 10.4 to 11.0. The left y-axis represents Recovered AF Output Voltage in mV on a logarithmic scale from 1 to 500. The right y-axis represents Distortion in % on a logarithmic scale from 0.1 to 10. The AF Output curve (solid line) shows a peak of approximately 100 mV between 10.6 MHz and 10.9 MHz, with a dip to about 6 mV at 10.5 MHz. The Distortion curve (dashed line) shows a minimum of about 0.5% in the same frequency range, with peaks of about 2% at 10.5 MHz and 10.9 MHz.

Frequency (MHz)	Recovered AF Output Voltage (mV)	Distortion (%)
10.4	40	-
10.5	6	2
10.6	80	0.5
10.7	100	0.5
10.8	100	0.5
10.9	80	2
11.0	10	-

Input signal conditions

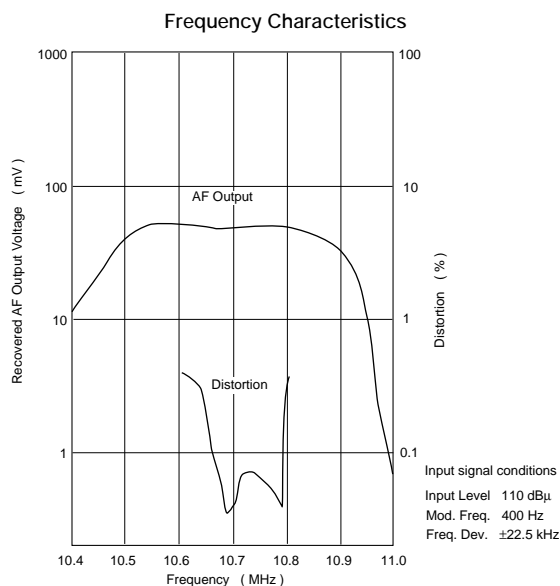
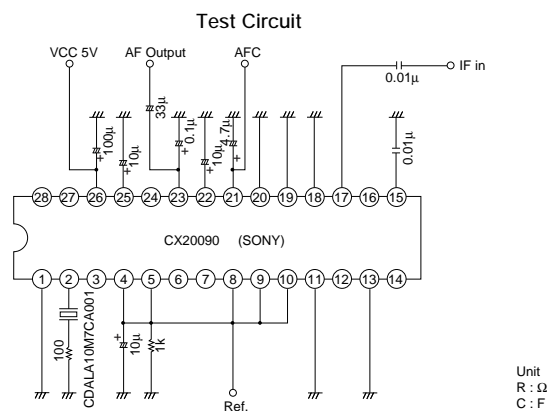
Input Level	80dBμ
Mod.Freq.	1000Hz
Freq.Dev.	±22.5kHz

Input signal conditions	
Input Level	80dBμ
Mod.Freq.	1000Hz
Freq.Dev.	±22.5kHz

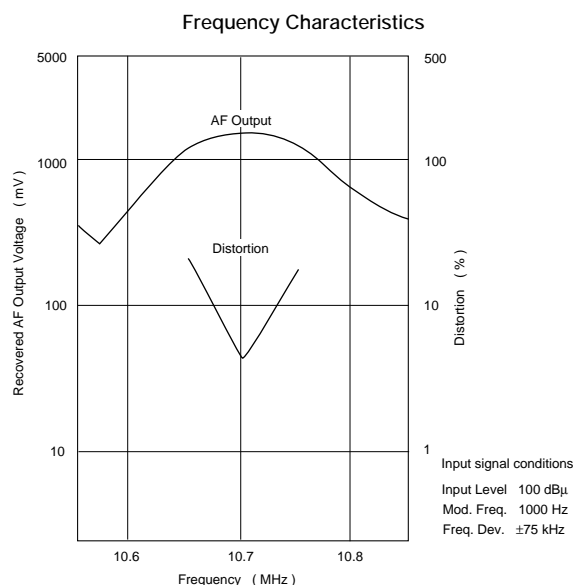
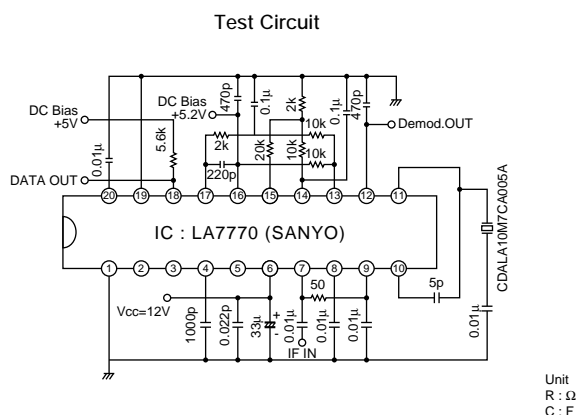
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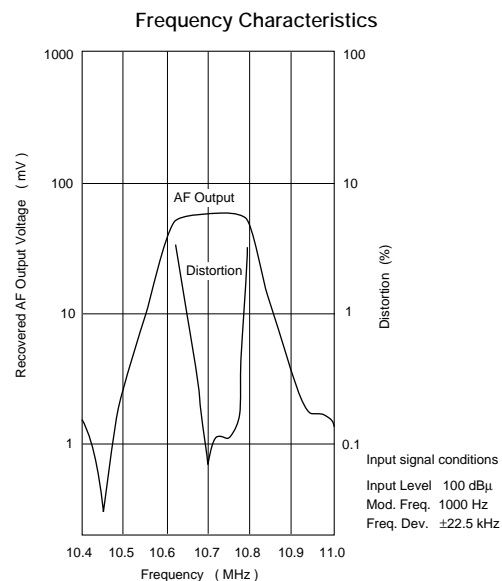
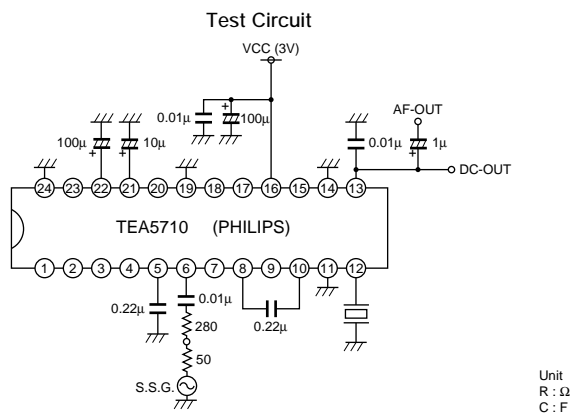
CDALA10M7CA001-B0



CDALA10M7CA005A-B0



CDALA10M7CA040-B0



Lead Type Discriminators Notice

■ Notice (Soldering and Mounting)

The component cannot be withstand washing.

■ Notice (Handling)

1. Do not use this product with bend. The component may be damaged if excess mechanical stress is applied to it mounted on the printed circuit board.
2. The component may be damaged when an excess stress will be applied.
3. All kinds of re-flow soldering must not be applied on the component.
4. Do not clean or wash the component as it is not hermetically sealed.
5. Do not use strong acidity flux, more than 0.2wt% chlorine content, in flow soldering.
6. In case of covering discriminator with over coat, conditions such as material of resin, cure temperature, and so on should be evaluated well.
7. Accurate test circuit values are required to measure electrical characteristics. It may be a cause of mis-correlation if there is any deviation, especially stray capacitance, from the test circuit in the specification.

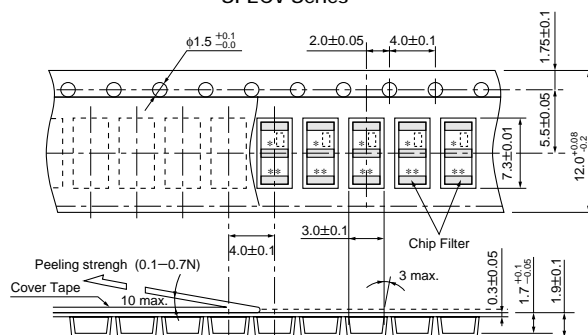
Packaging

■ Minimum Quantity

Part Number	Taping ø180mm	Ammo Pack	Bulk
SFECV	2,000		
SFECS	2,000		
SFELA		1,500	500
SFELB		1,500	500
SFVLA		1,000	500
SFKLA		1,500	500
SFTLA			500
CDACV / CDSCA	2,000		
CDALA		1,500	500

■ Chip Type CERAFIL®

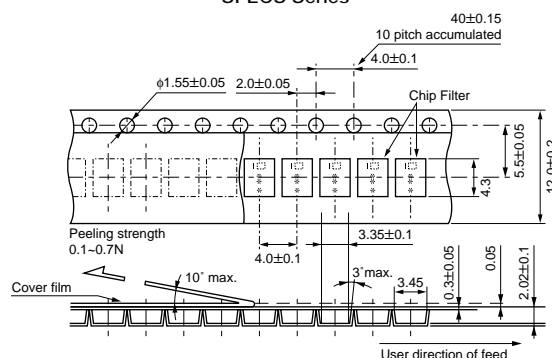
SFECV Series



Part number marked side is always facing upside.
The feeding holes side of cavity tape is always input terminal.

■ Small Chip Type CERAFIL®

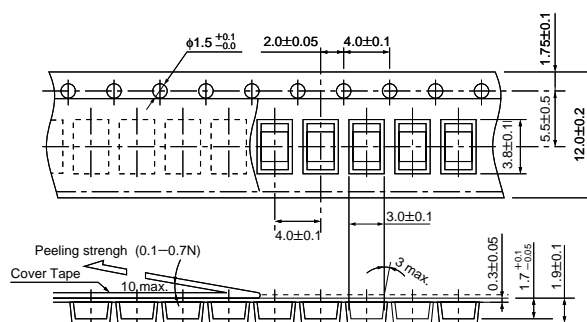
SF ECS Series



- Part Number marked side is always facing upside.
- The feeding holes side of cavity tape is always input terminal.

■ Chip Type Discriminator

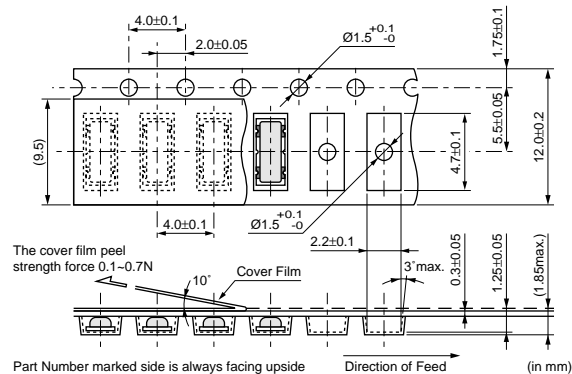
CDACV Series




Part number marked side is always facing upside. User Direction of Feed

■ Chip Type Low-Profile Type Discriminator

CDSCA Series



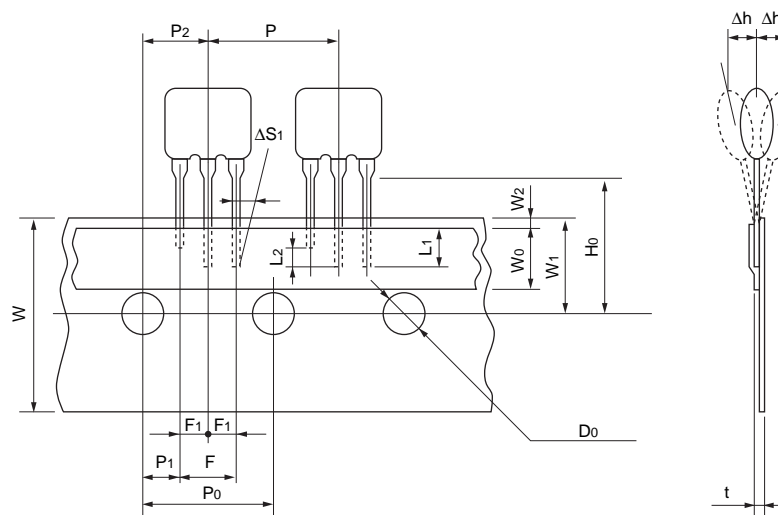
Part Number marked side is always facing upside (in mm)

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Packaging

Continued from the preceding page.

Lead Type CERAFIL® SF_LA Series



Item	Code	Dimensions	Tolerance	Remarks
Lead Length under the Hold Down Tape	L1	3.0 min.		
Length of Cat off	L2	2.0 max.		To distinguish the direction
Pitch of Components	P	12.7	±0.5	
Pitch of Sprocket Hole (1)	P0	12.7	±0.2	
Length from Hole Center to Lead	P1	3.85	±0.5	
Length from Hole Center to Component Center	P2	6.35	±0.5	
Pitch of the Terminal (1)	F	5.0	+0.5 -0.2	
Pitch of the Terminal (2)	F1	2.5	±0.2	
Slant to the Forward or Backward	Δh	0	±1.0	
Slant to the Left or Right	ΔS1	0	±1.0	
Width of Carrier Tape	W	18.0	±0.5	
Width of Hold Down Tape	W0	6.0 min.		Must not protrude to the carrier tape
Position of Sprocket Hole	W1	9.0	±0.5	
Gap of Hold Down Tape and Carrier Tape	W2	0	+0.5 -0	
Distance Between the Center of Sprocket Hole and Lead Stopper	H0	18.0	±0.5	
Diameter of Sprocket Hole	D0	ø4.0	±0.2	
Total Tape Thickness	t	0.6	±0.2	
Pitch of Sprocket Hole (2)	P020	254.0	±1.5	The pitch of 20 sprocket holes

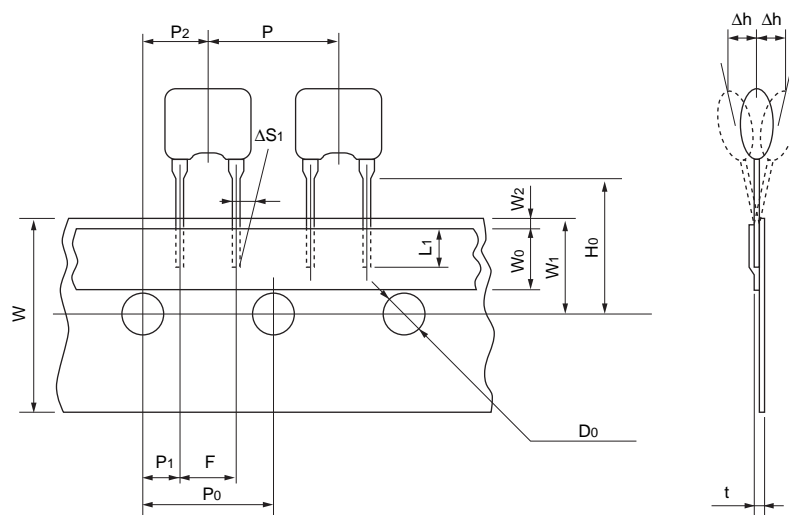
(in mm)

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Packaging

Continued from the preceding page.

Lead Type Discriminator CDALA Series



Item	Code	Dimensions	Tolerance	Remarks
Lead length under the hole down tape	L1	3.0 min.	—	
Pitch of component	P	12.7	±0.5	
Pitch of sprocket hole (1)	P0	12.7	±0.2	
Length from hole center to lead	P1	3.85	±0.5	
Length from hole center to component center	P2	6.35	±0.5	
Lead spacing	F	5.0	+0.5 -0.2	
Slant to the forward or backward	Δh	0	±1.0	
Slant to the left or right	ΔS_1	0	±1.0	
Width of carrier tape	W	18.0	±0.5	
Width of hold down tape	W0	6.0 min.	—	
Position of sprocket hole	W1	9.0	±0.5	
Gap of hold down tape and Carrier tape	W2	0	+0.5 -0.0	Hold down tape doesn't exceed the carrier tape
Distance between the center of sprocket hole and lead stopper	H0	18.0	±0.5	
Diameter of sprocket hole	D0	ø4.0	±0.2	
Total tape thickness	t	0.6	±0.2	
Pitch of sprocket hole (2)	Po20	254.0	±1.5	The pitch of 20 sprocket holes

(in mm)

Test Circuit of Ceramic Discriminator

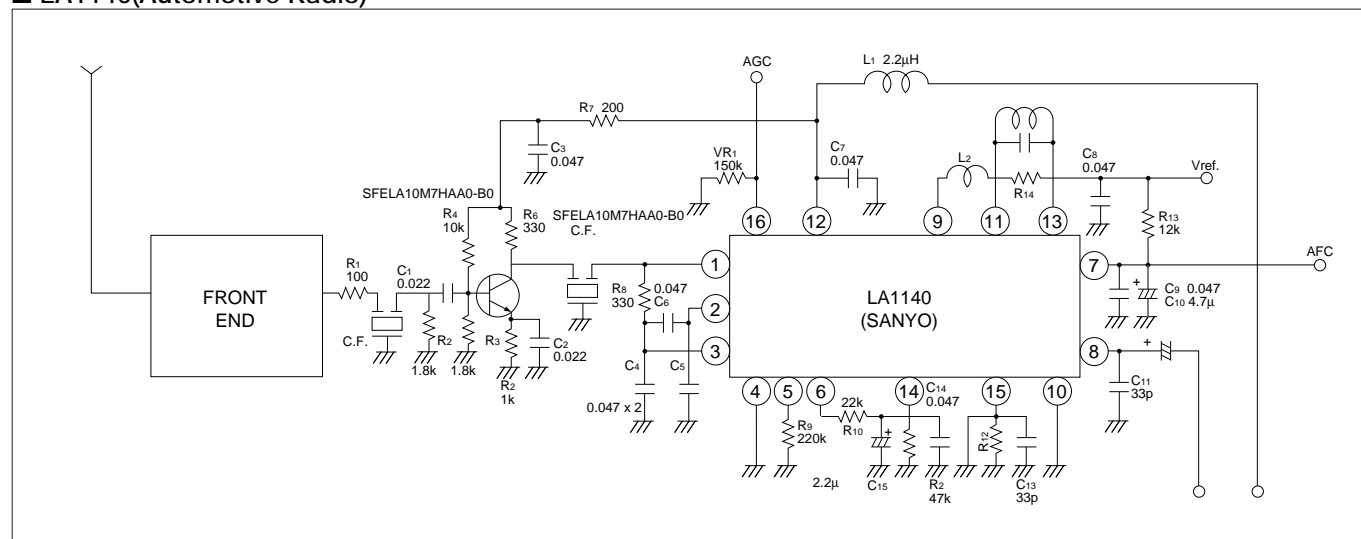
Part Number	IC Manufacturer	IC
CDALA10M7GA001	Sony	CX20029
CDALA10M7GA002	Sony	CX20076
CDALA10M7GA004	Rohm	BA4234L
CDALA10M7GA005	Rohm	BA4230AF
CDALA10M7GA006	Toshiba	TA7640AP
CDALA10M7GA007	Sanyo	LA1260
CDALA10M7GA008	Toshiba	TA7303P
CDALA10M7GA009	Toshiba	TA7130P
CDALA10M7GA011	Panasonic	AN7004
CDALA10M7GA012	Sony	CXA1030P
CDALA10M7GA013	Panasonic	AN7007SU
CDALA10M7GA014A	Panasonic	AN7006S
CDALA10M7GA015	Sanyo	LA1816
CDALA10M7GA016	Toshiba	TA8122AN/F
CDALA10M7GA017	Philips	TEA5591
CDALA10M7GA018	Toshiba	TA8132AN/AF
CDALA10M7GA019	Rohm	BA1440
CDALA10M7GA020	Philips	NE604
CDALA10M7GF021A	Philips	TBA229-2
CDALA10M7GA022	Sanyo	LA1810
CDALA10M7GA023	Sanyo	LA7770
CDALA10M7GF024	Philips	TDA2557
CDALA10M7GA025	Telefunken	U829B
CDALA10M7GA026	Sanyo	LA1805
CDALA10M7GA027	Sony	CXA1238
CDALA10M7GA027N	Sony	CXA1238N
CDALA10M7GA028	Telefunken	U2501B
CDALA10M7GA029	Philips	TBA120U
CDALA10M7GA030	Philips	TEA5592
CDALA10M7GA031	Toshiba	TA2003
CDALA10M7GA032	Sony	CXA1343M
CDALA10M7GA033	Toshiba	TA2007N
CDALA10M7GA034V	Telefunken	U4490B
CDALA10M7GA035	Philips	TEA5594
CDALA10M7GA036	Toshiba	TA2029
CDALA10M7GA037	Sanyo	LA1830
CDALA10M7GA038	Siemens	TDA6160X
CDALA10M7GA039	Toshiba	TA8186
CDALA10M7GA040	Philips	TEA5710
CDALA10M7GA041	Rohm	BA4220
CDALA10M7GA042	Philips	SA605
CDALA10M7GA043	Sanyo	LA1831
CDALA10M7GA044	Siemens	TDA6160-2X
CDALA10M7GA045	Toshiba	TA2008A/AN
CDALA10M7GA046	Sanyo	LA1832/M
CDALA10M7GA047	Philips	SA626
CDALA10M7GA048	Sanyo	LA1835/M
CDALA10M7GA049	Motorola	MC13156
CDALA10M7GA050	Toshiba	TA2022
CDALA10M7GA051	Siemens	TDA1576T
CDALA10M7GA052	Motorola	MC13173
CDALA10M7GA053	Panasonic	AN7232
CDALA10M7GA054	Sony	CXA1376AM
CDALA10M7GA055	Philips	TEA5712T
CDALA10M7GA056	NEC	μPC1391M
CDALA10M7GA057	Toshiba	TA2057
CDALA10M7GA058	Toshiba	TA2046
CDALA10M7GA059	Samsung	KA2244
CDALA10M7GA060	Rohm	BA1448
CDALA10M7GA061	Philips	TEA5762/5757

Part Number	IC Manufacturer	IC
CDALA10M7GF062	Toko	TK14581
CDALA10M7GA063	Samsung	KA2292
CDALA10M7GA064	Samsung	KA2295
CDALA10M7GA065	Samsung	KA2298
CDALA10M7GA066	Rohm	BA4110
CDALA10M7GA067	Rohm	BA4240L
CDALA10M7GA068	Sony	CXA1991N
CDALA10M7GA069	Sony	CXA1538M/N/S
CDALA10M7GA070	Sanyo	LA1150
CDALA10M7GA071	Toshiba	TA7765
CDALA10M7GF072	Toshiba	TA31161
CDALA10M7GA073	Motorola	MC13158
CDALA10M7GA075	Sony	CXA1611
CDALA10M7GA076	Sony	CXA3067M
CDALA10M7GA077	Toshiba	TA2111
CDALA10M7GA078	Sony	CX1691M
CDALA10M7GA079	Sanyo	LA1838/M
CDALA10M7GA080	Toshiba	TA2104AFN
CDALA10M7GA080A	Toshiba	TA2104F
CDALA10M7GA081	Telefunken	U4313B
CDALA10M7GA082	Toshiba	TA2099N
CDALA10M7GA083	Sanyo	LA1827
CDALA10M7GA084	Rohm	BH4126FV
CDALA10M7GA085	Philips	SA639
CDALA10M7GA086	Sanyo	LA1833
CDALA10M7GA087	Motorola	MC3363
CDALA10M7GA088	Toshiba	TA8721ASN
CDALA10M7GA089	Samsung	KA22425
CDALA10M7GA090	Samsung	KA22901
CDALA10M7GA091	Samsung	KA2297
CDALA10M7GA092	Toshiba	TA2132
CDALA10M7GA092D	Toshiba	TA2132BP
CDALA10M7GA093	Sony	CXA1111
CDALA10M7GA094	Sanyo	LA1822
CDALA10M7GA095	Temec	U2765B
CDALA10M7GA096	Philips	SA636DK
CDALA10M7GA097	Matsushita	AN6138SH
CDALA10M7GA098	Philips	CAA3220TS
CDALA10M7GA100	Toshiba	TA2149N
CDALA10M7GA100A	Toshiba	TA2149AN
CDALA10M7GA101	Sanyo	LA1823
CDALA10M7GA102	Toshiba	TA2142FN
CDALA10M7GA103	Samsung	KB22902
CDALA10M7GA104	Rfmd	RF2925
CDALA10M7GA105A	Philips	TEA5757HL
CDALA10M7GA106	Fujitsu	MB15G611
CDALA10M7GF107	Toshiba	TA31272FN
CDALA10M7GF108A	Sanyo	LA1225M
CDALA10M7GF109	Toko	TK14588
CDALA10M7GA110	Dspg	DS9RF21

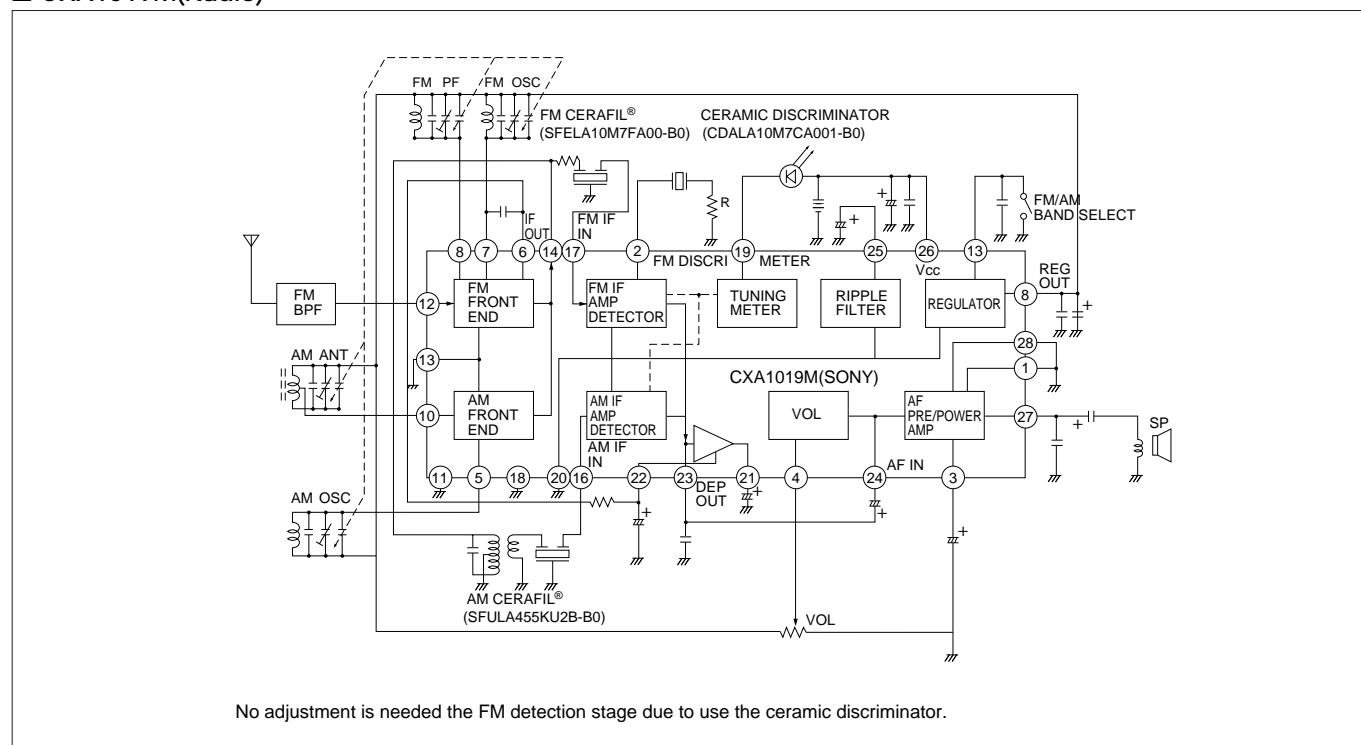
Part Number	IC Manufacturer	IC
CDALA10M7CA001	Sony	CX20091
CDALA10M7CA002	Toshiba	TA7687P/F
CDALA10M7CA004A	Motorola	MC3356P
CDALA10M7CA005A	Sanyo	LA7770
CDALA10M7CA006	Philips	TEA5591
CDALA10M7CA009	Toshiba	TA7640AP
CDALA10M7CA040	Philips	TEA5710

Example of Applied Circuit

LA1140(Automotive Radio)



CXA1019M(Radio)

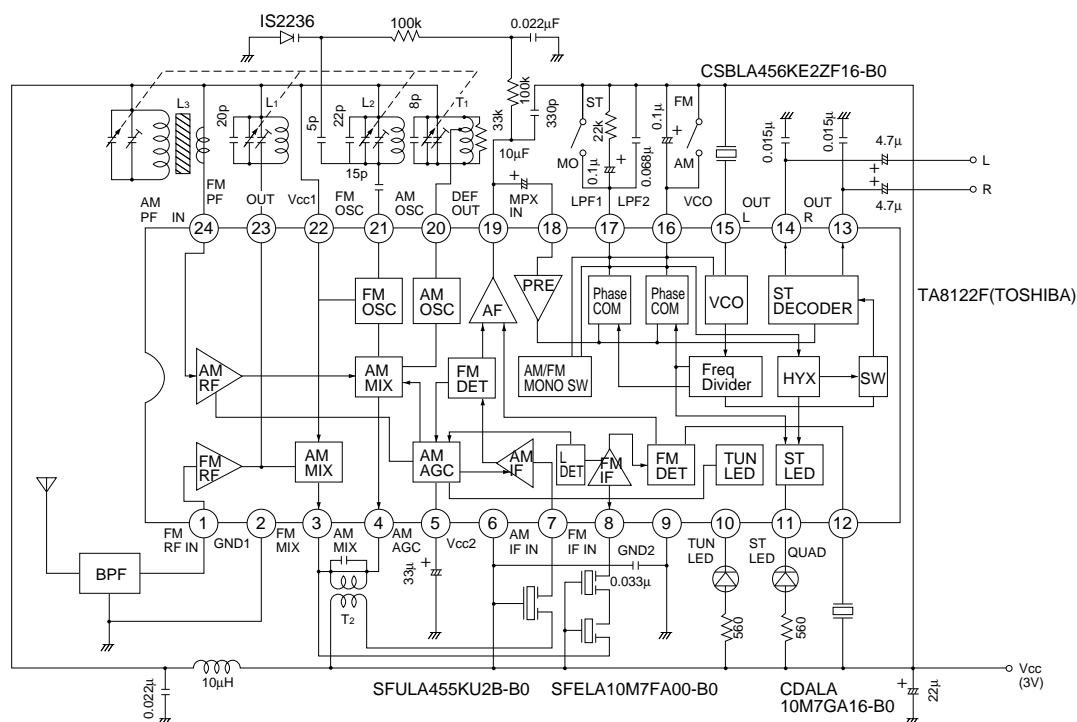


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Example of Applied Circuit

Continued from the preceding page.

TA8122F(Radio)



Detection and MPX stage adjustment ceramic discriminator and ceramic resonator (CERALOCK®)

⚠ Note:

1. Export Control

〈For customers outside Japan〉

Murata products should not be used or sold for use in the development, production, stockpiling or utilization of any conventional weapons or mass-destructive weapons (nuclear weapons, chemical or biological weapons, or missiles), or any other weapons.

〈For customers in Japan〉

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2. Please contact our sales representatives or product engineers before using our products listed in this catalog for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property, or when intending to use one of our products for other applications than specified in this catalog.

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- ② Aerospace equipment
- ③ Undersea equipment
- ④ Power plant equipment
- ⑤ Medical equipment
- ⑥ Transportation equipment (vehicles, trains, ships, etc.)
- ⑦ Traffic signal equipment
- ⑧ Disaster prevention / crime prevention equipment
- ⑨ Data-processing equipment
- ⑩ Application of similar complexity and/or reliability requirements to the applications listed in the above

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